

Sensor development and test

Ester Ricci

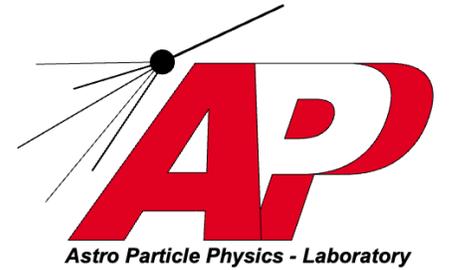
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Università di Trento

INFN – TIFPA

SPES Kickoff meeting,

The APP group @ UNITN



Constituted at the beginning of 2017

Group composition:

- 1 Full professor: R. Battiston
- 2 Associate professors: R. Iuppa, P. Zuccon
- 4 Fixed term researchers: F. Dimiccoli, F.M. Follega, A. Perinelli, E. Ricci
- Dottorandi: M. Babu, G. Brianti, L. Cavazzini, A. Dass, A. Lega, D. Mascione, R. Nicolaidis, F. Rossi

INFN-TIFPA members connected to the group:

- 2 researchers: F. Nozzoli, W. Burger
- 1 technologist: C. Neubuser
- 1 junior researcher: V. Vilona

Two core activities:

- hardware development for space experiments
- machine learning techniques for data analysis in high energy physics

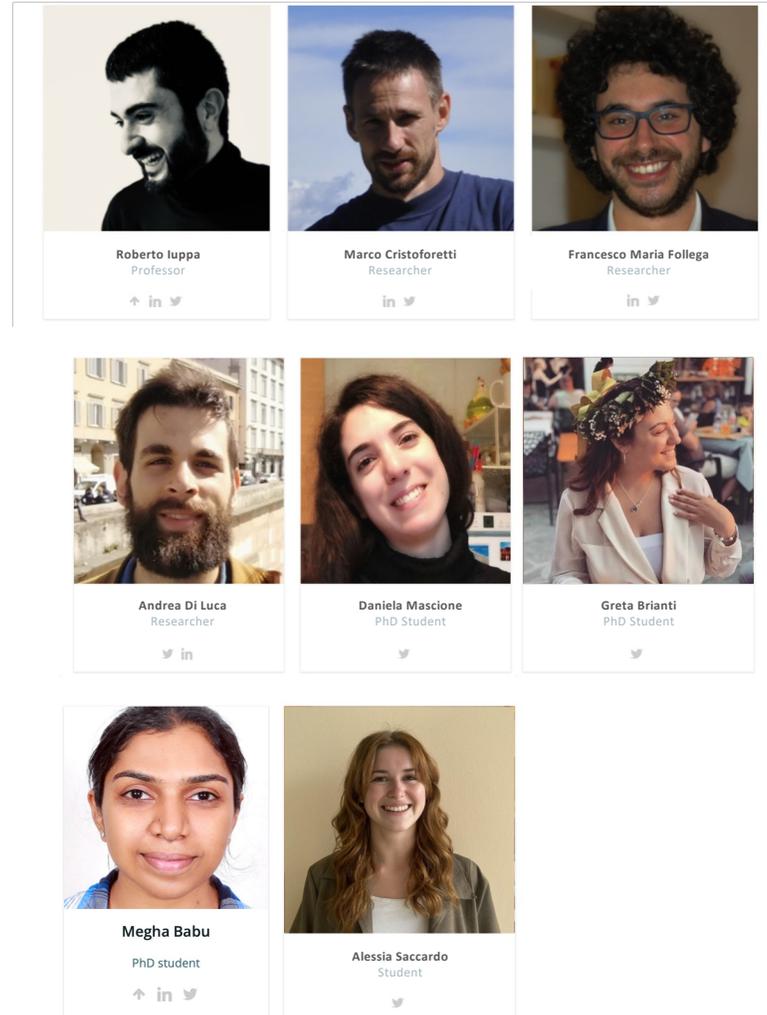
DEEPPP initiative



The **Deep Learning for Particle Physics** initiative is the software and analysis part of the APP group. They work on ATLAS on:

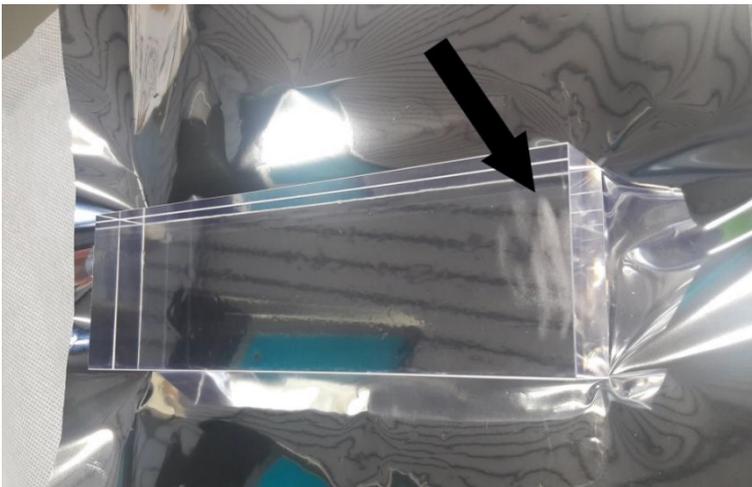
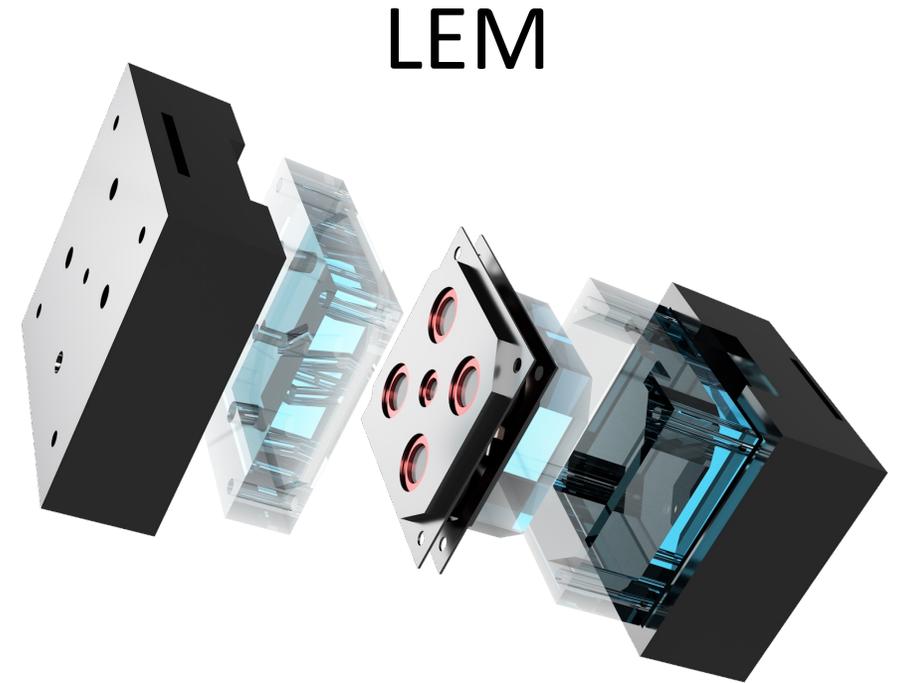
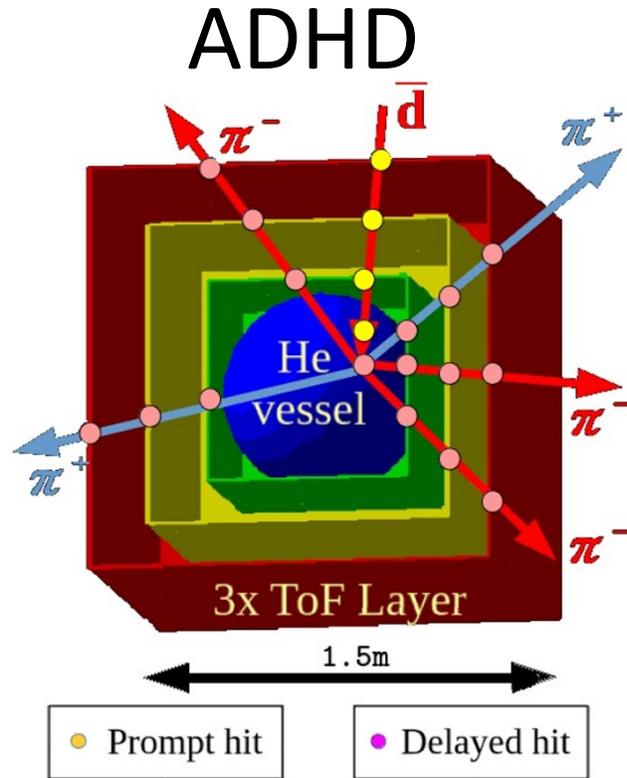
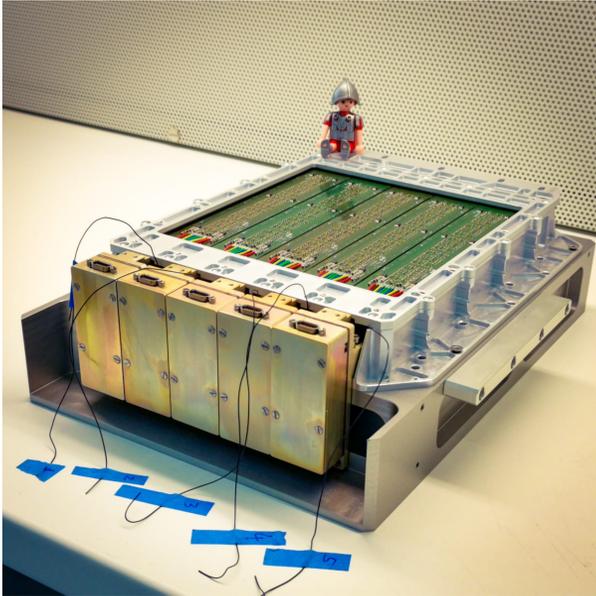
- Data quality monitoring (online and offline)
- Taggers development
- R&D for future online trigger implementation

And on Limadou data analysis



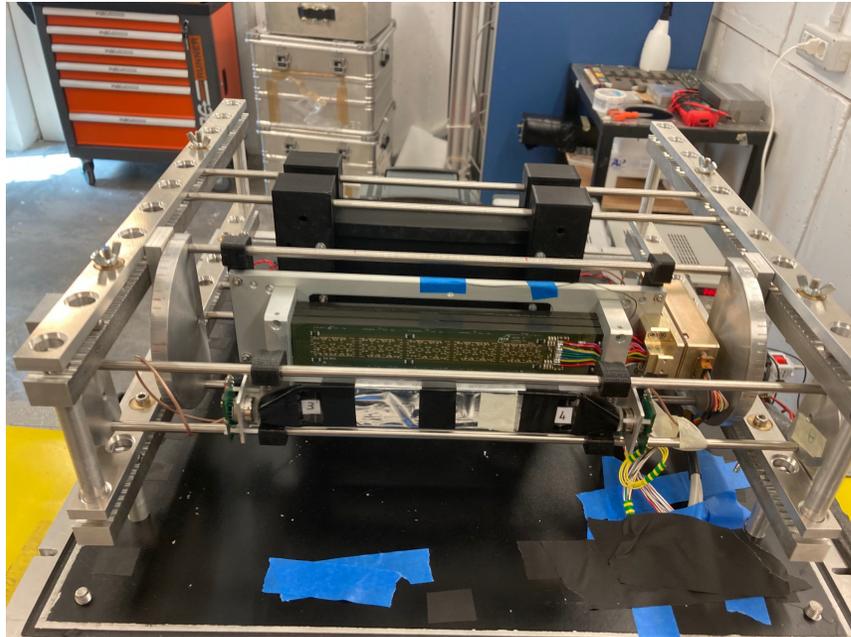
The hardware development team

HEPD-02

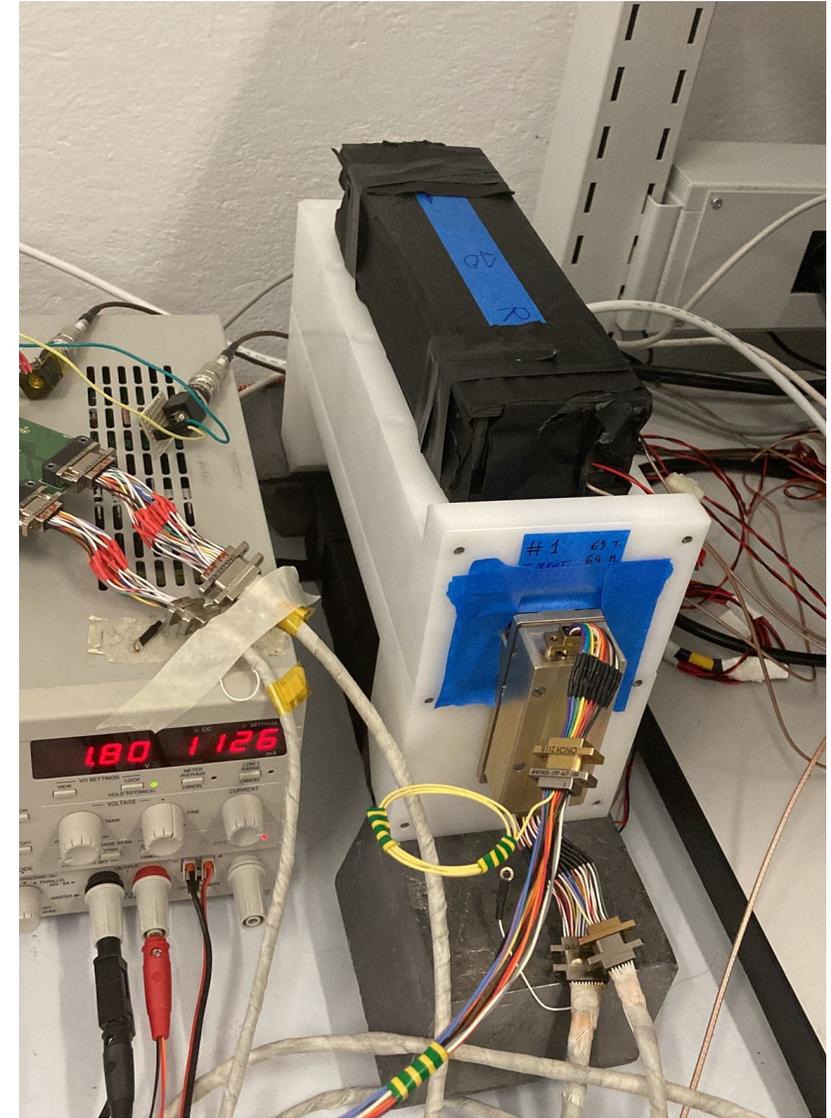
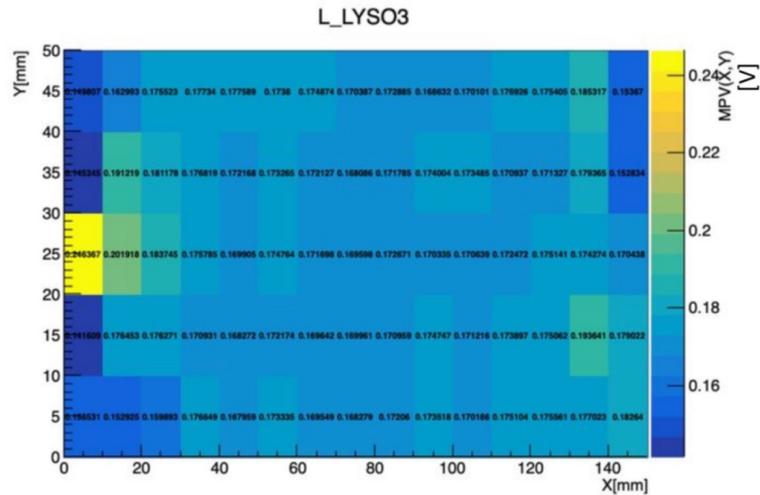
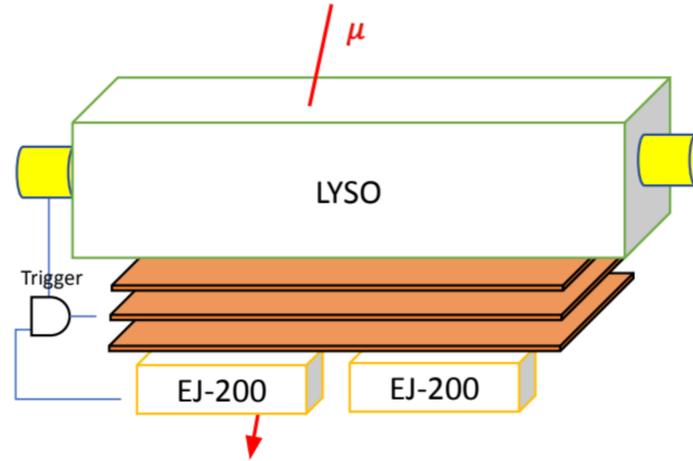


Team: R. Iuppa, A. Lega, R. Nicolaidis, F. Nozzoli, E. Ricci, P. Zuccon

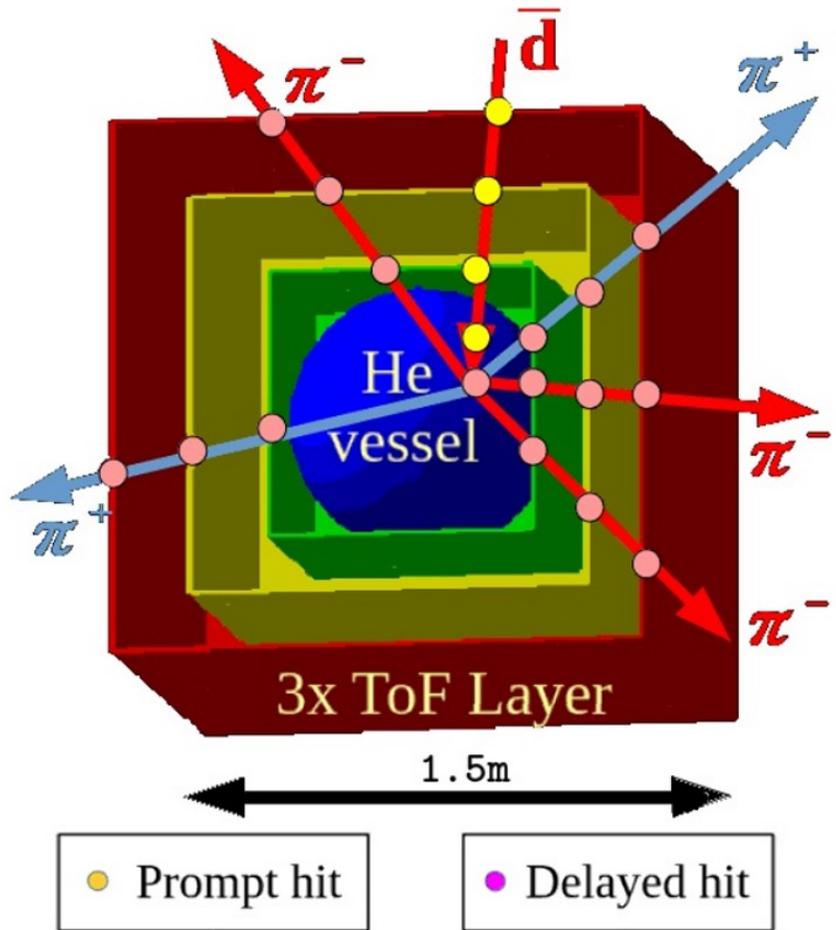
LYSO characterisation



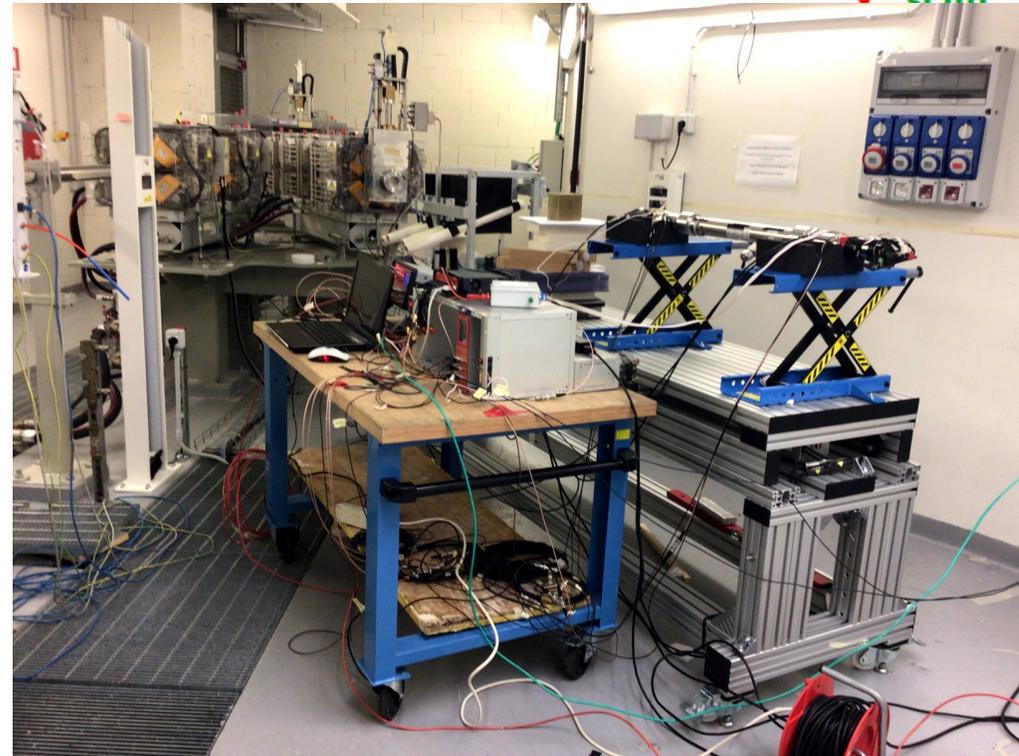
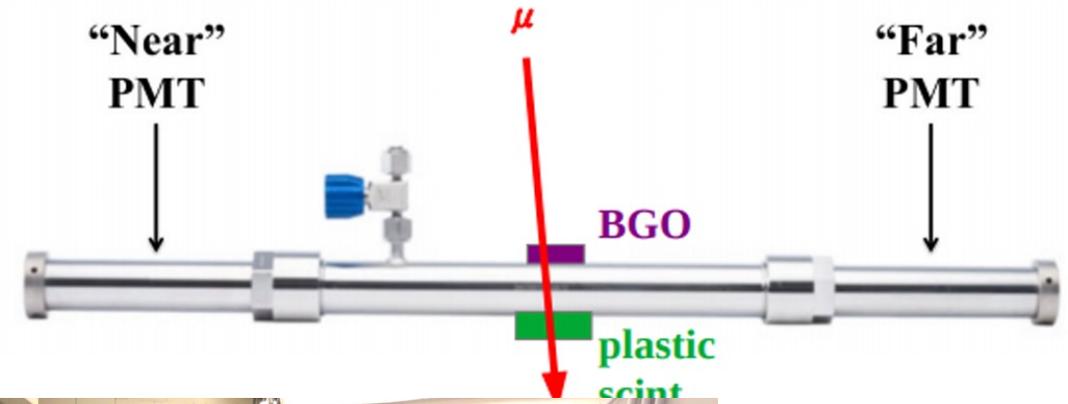
LYSO + HEPD-02 turret
Beam tests



ADHD

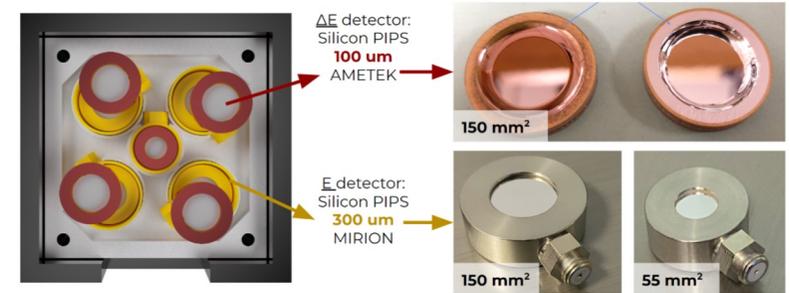


PRIN project taking off



LEM detector

- LEM: Compact particle spectrometer ($10 \times 10 \times 10 \text{ cm}^3$)
- Active collimation
standard tracking spoils direction (multiple scattering)

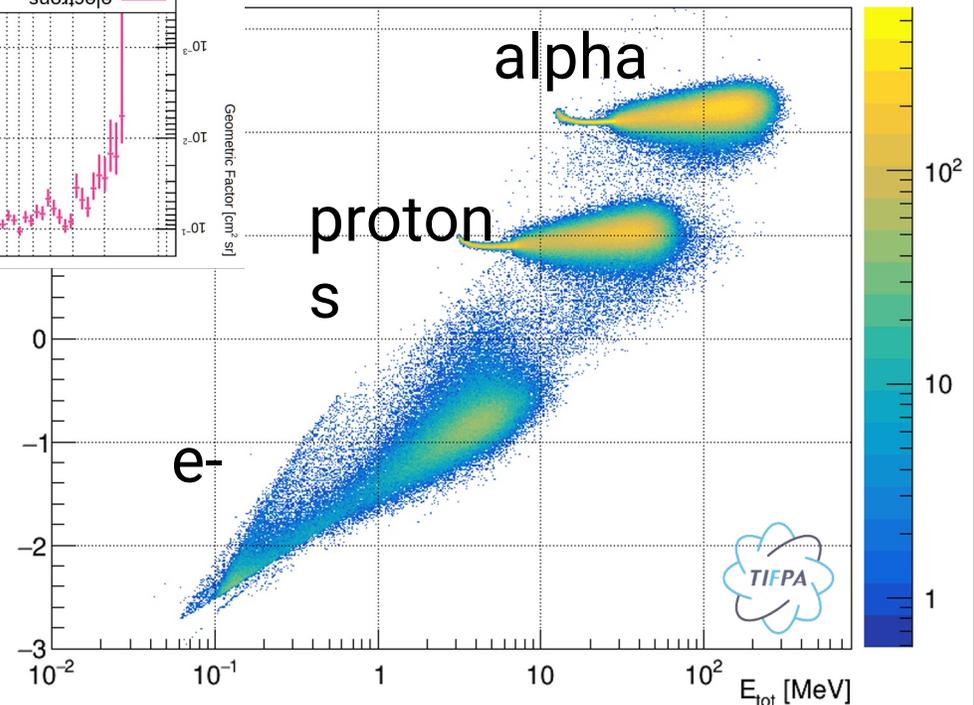
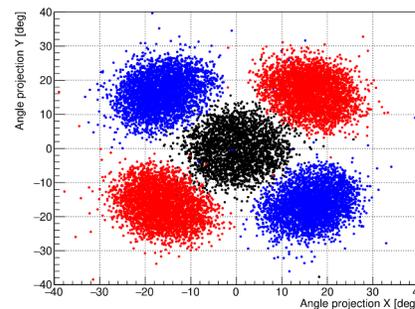
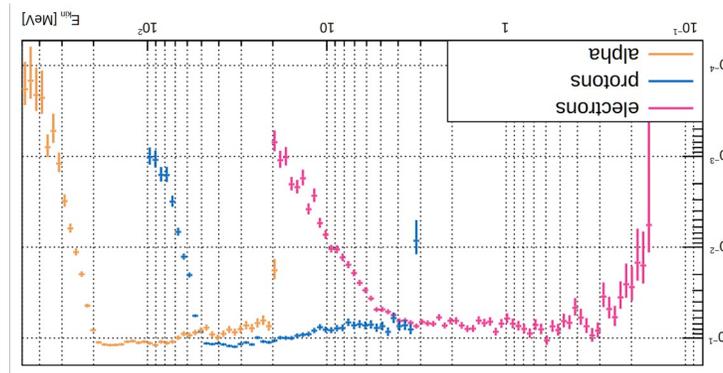


- $\Delta E - E$ technique: Energy - PID
 - e- [0.1 - 7] MeV
 - proton [3 - 15] MeV
 - alpha [11 - 200] MeV

- Angle res:
 - ~12 degs e-
 - ~6 degs protons/alpha

- Geometric factor $\sim 0.1 \text{ cm}^2\text{sr}$

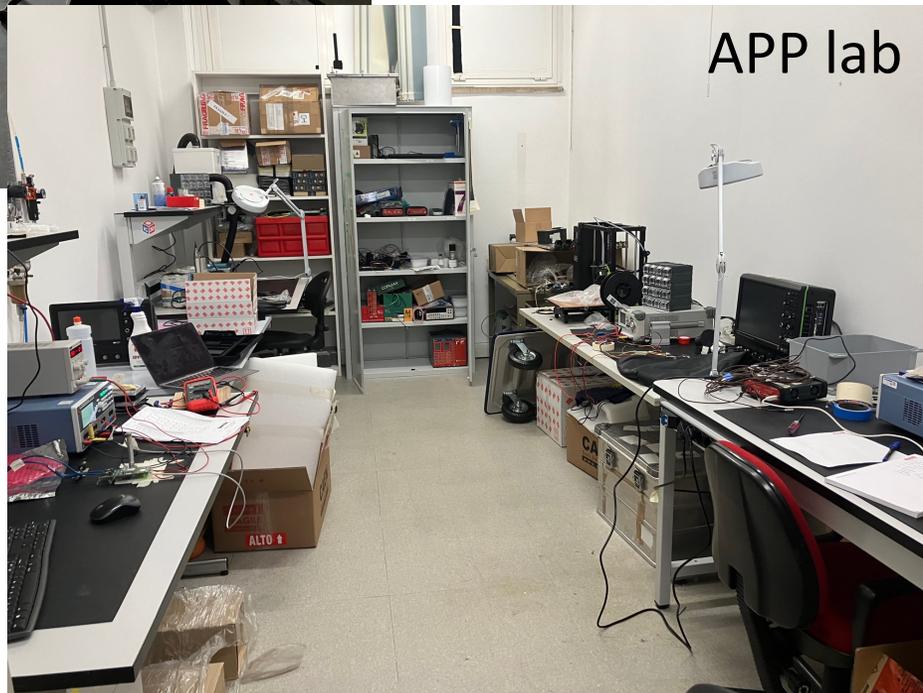
- Two operation modes:
 - List mode (below 1 kHz)
 - Histo mode (trig rate > 1 kHz)



Labs and infrastructures @ Povo



TIFA clean room



APP lab

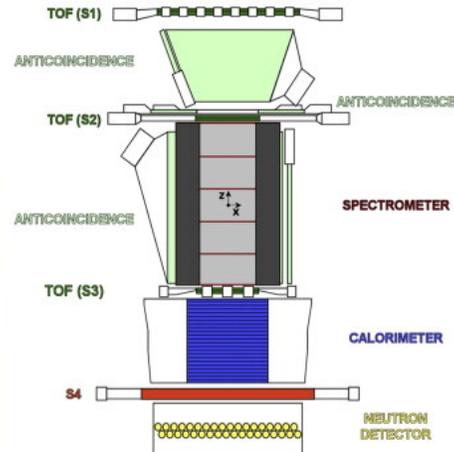
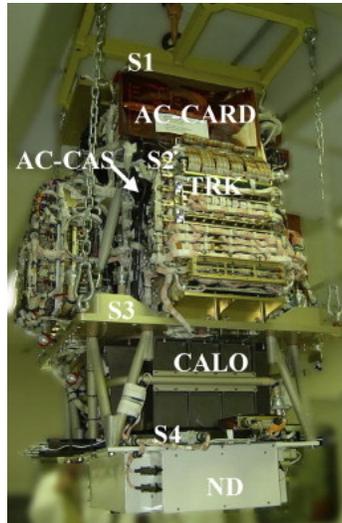


Climate Chamber

Mechanical Workshop
Electronics Workshop

Magnetic spectrometers

PAMELA



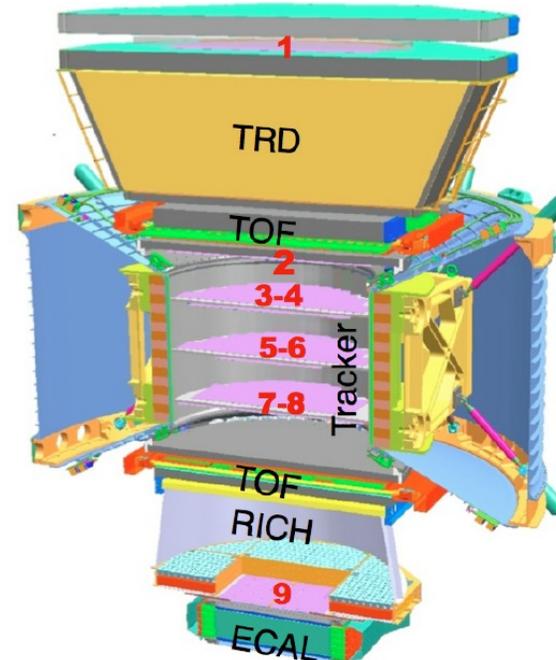
<https://doi.org/10.1016/j.asr.2007.07.023>

- Measurements of **antimatter fluxes** and **isotopic composition** of cosmic rays
- Begin of operations: June 2006
- End of operations: February 2016
- Equipped with **6 planes of silicon microstrip detectors**
- Double sided microstrip detector
- Silicon surface: **0.13 m²**



AMS-02

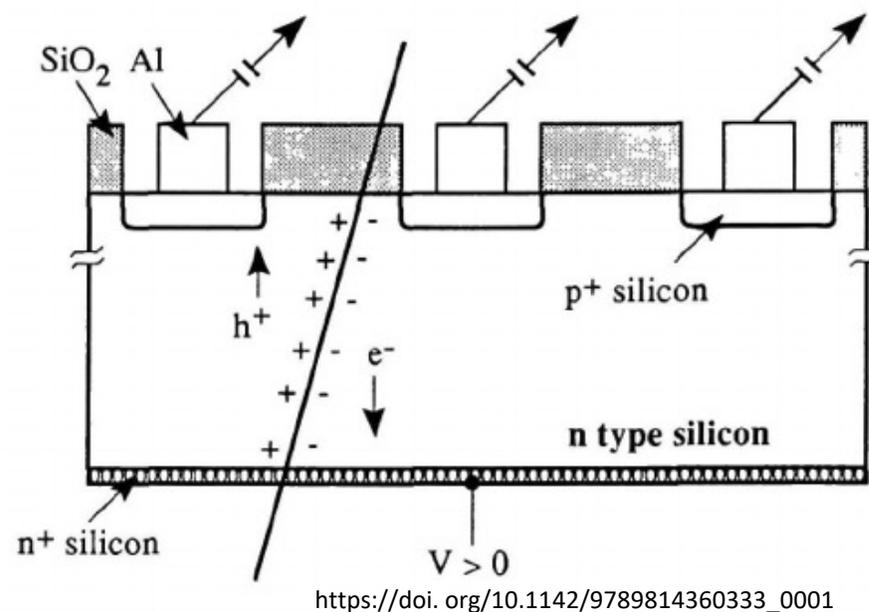
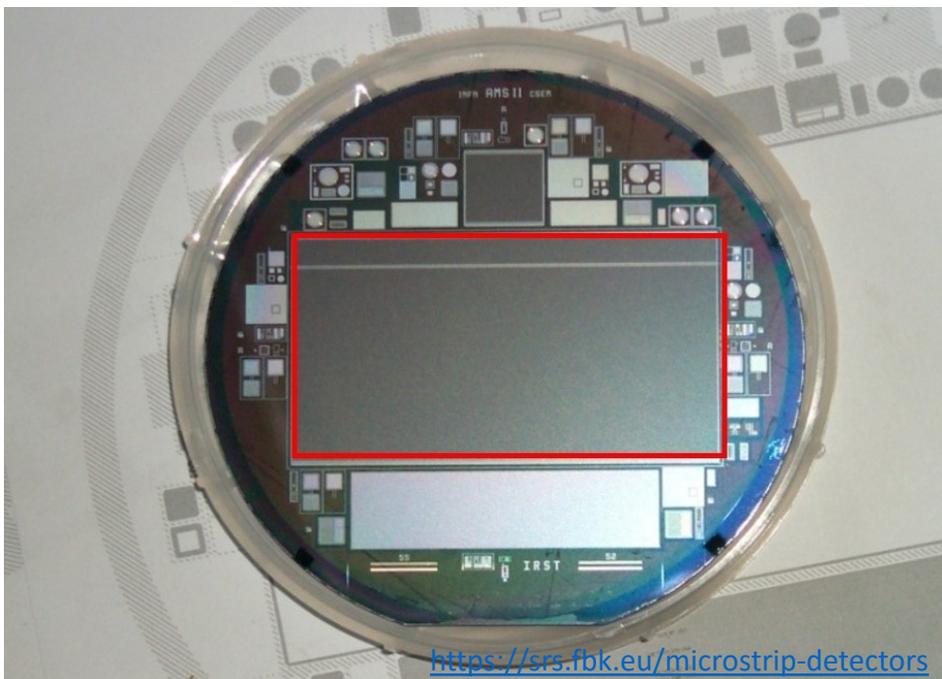
- Search of **dark matter** and study of **antimatter fluxes**
- Begin of operations: May 2011
- Equipped with **nine planes of silicon microstrip detector**
- Double sided microstrip detector
- Silicon surface: **6.4 m²**



<https://doi.org/10.1051/epjconf/20147000026>

Silicon microstrip detectors

- Developed for vertexing and momentum measurement
- Silicon microstrip detectors are the **elective technology for tracking particles in space**
- Charged particle crossing a silicon buffer produces electron-hole pairs.
- Implanting segmented electrodes for the collection, it is possible to measure the position where the particle cross the detector.



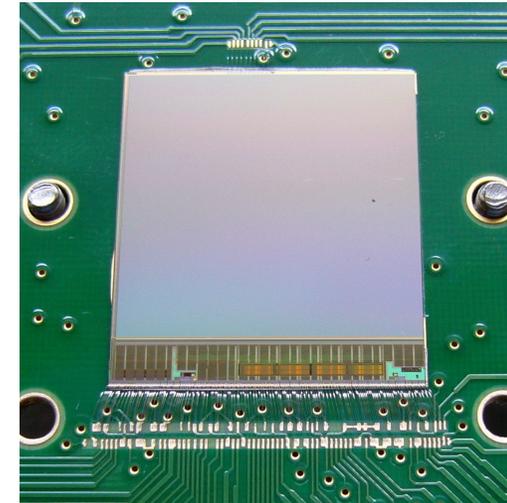
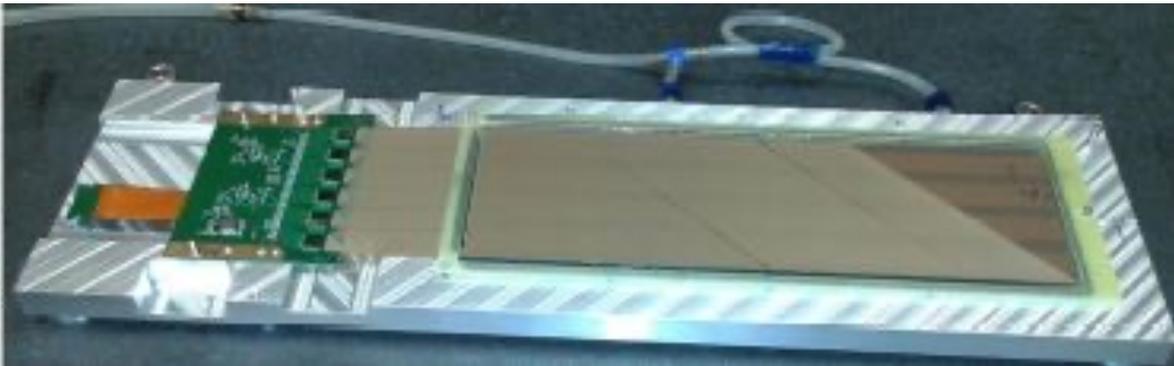
Microstrip vs MAPS detectors

Microstrip advantages:

- Small number of channels
- Low power consumption

Microstrip limits:

- Detector procurement
- High costs (~ 100 \$/cm²)
- Custom readout (high costs of procurement and integration)
- Reduced noise control due to external amplification



<https://doi.org/10.1088/1748-0221/7/01/C01102>

MAPS detector advantages:

- Standard CMOS procedures used allow mass production
- Lower costs (~ 20 \$/cm²)
- Readout implanted on detector surface
- Small noise (amplification implanted on pixel)
- Good spatial resolution

MAPS detectors limits:

- High power consumption
- Large number of channels

Hybrid vs Monolithic pixels detectors

Hybrid pixel approach:

- A team realises the sensor structure
- A team realises the readout device

Advantages:

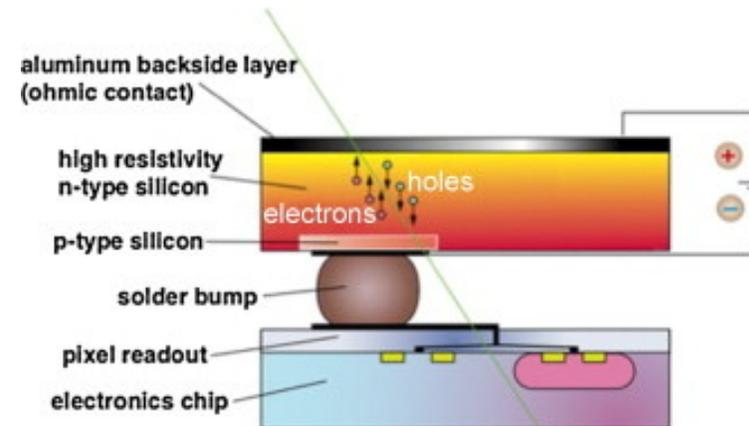
- It is possible to optimise the two parts independently
- The technology is well known and reliable

Disadvantages:

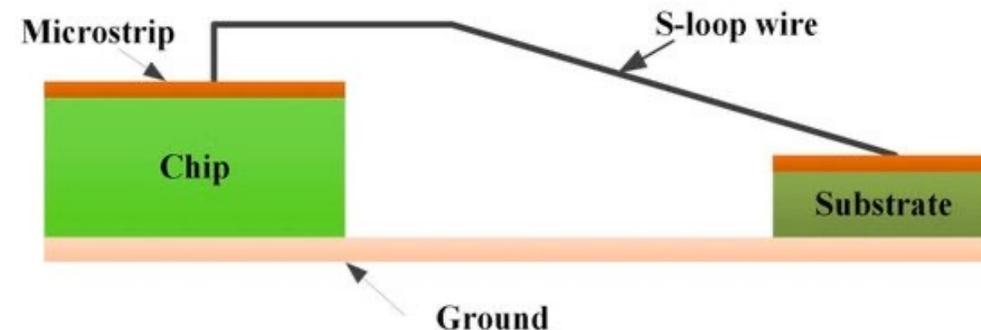
- Sensors are realised with custom technologies (high costs, lower expertise of foundries, only a few foundries accept the work)
- The assembly procedure is complex (high costs and low yield)
- Higher noise
- Technology is several decades years old, and already reached its maximum development

Solution:

- To implement the readout on the same substrate of the detector (**Monolithic approach**)



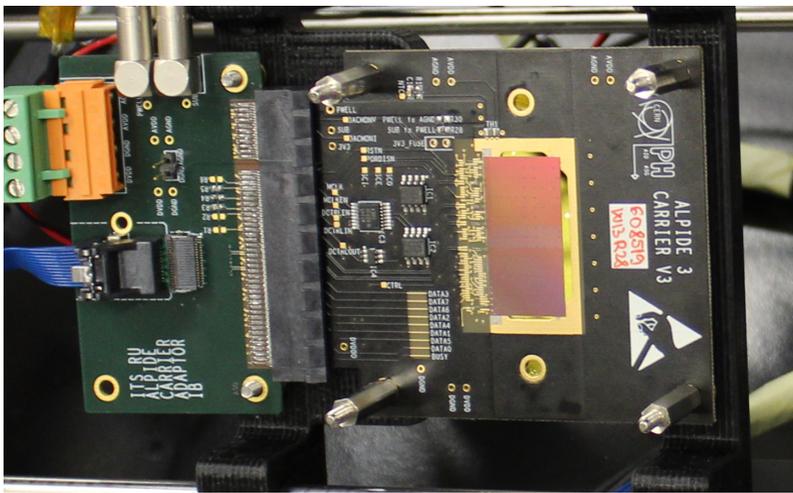
doi:<https://doi.org/10.1016/j.lssr.2015.06.006>



<https://doi.org/10.3390/electronics8030365>

Each readout channel requires a bond.
If readout is integrated, it is possible to use wire bonding and the number of bonds is widely reduced

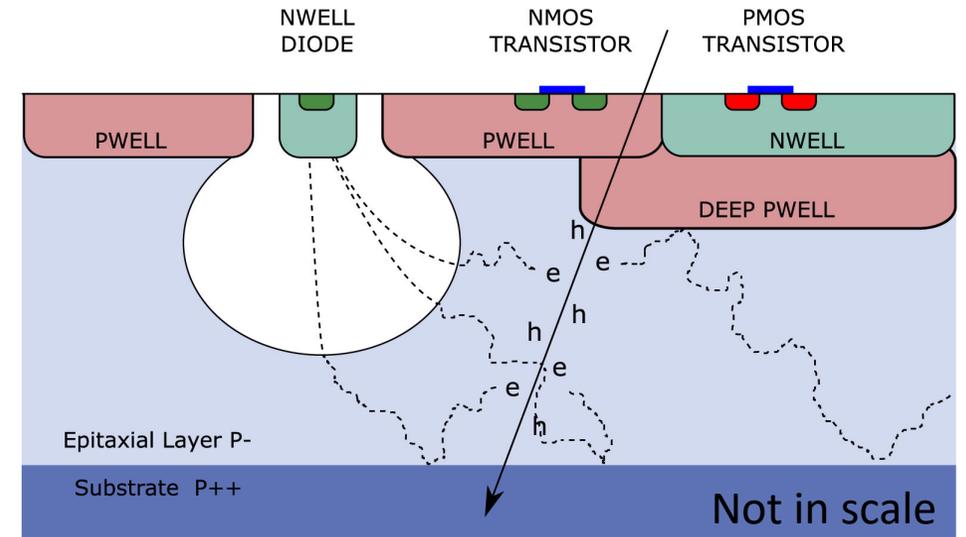
ALPIDE/ALTAI



ALPIDE is a MAPS detector designed for ALICE ITS Upgrade. The requirements for the upgrade are reported in the table.

Parameter	IB	OB	Final values
Detector size [mm ²]	15 x 30	15 x 30	15 x 30
Detector thickness [μm]	50	100	50 - 100
Spatial resolution [μm]	5	10	4
Detection efficiency	>99%	>99%	>99%
Fake hit rate [evt ⁻¹ pixel ⁻¹]	<10 ⁻⁵	<10 ⁻⁵	<10 ⁻⁷
Integration time [μs]	<30	<30	~2
Power density [mW/cm ²]	<300	<100	<50 *

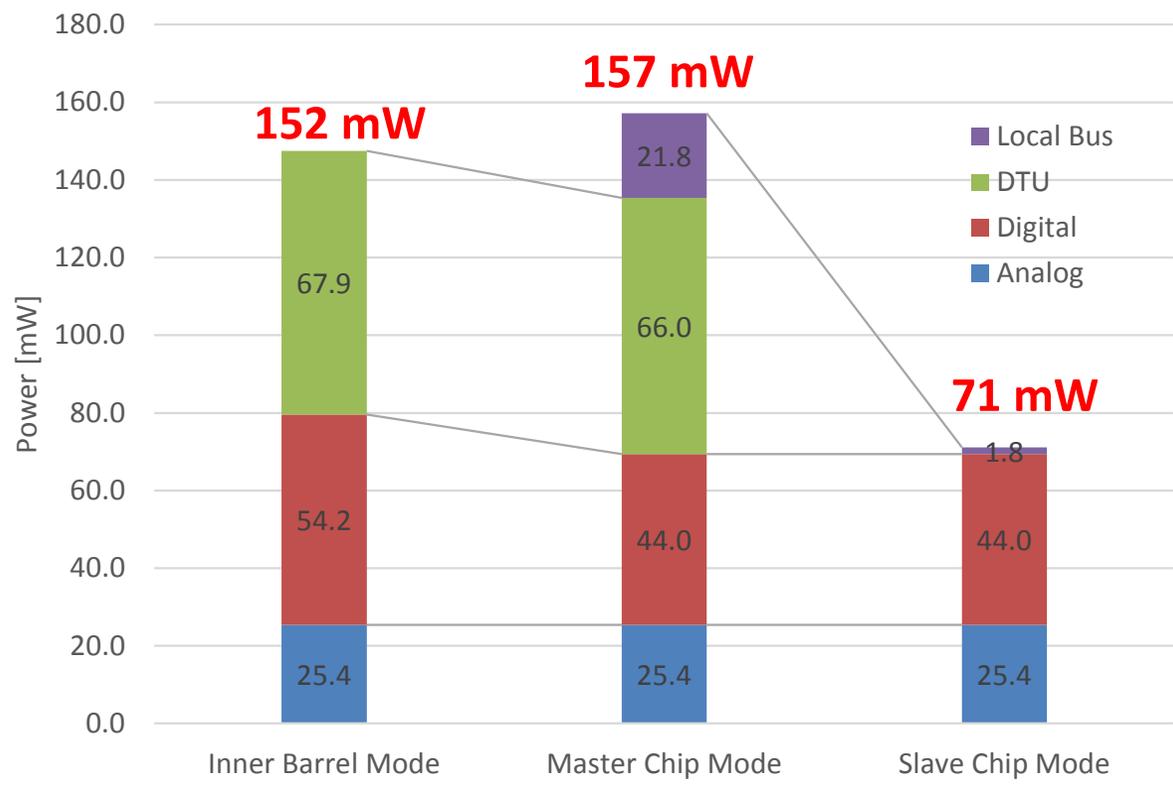
* The power consumption depends on the detector configuration



<https://doi.org/10.1088/0954-3899/41/8/087002>.

- Sparsified readout
- Pixel pitch: 26.88 x 29.24 μm²
- Columns x rows: 1024 x 512
- Electrode diameter: 2 μm
- Back bias: 0 V to -6 V
- Producer: TowerJazz

ALPIDE power consumption in ALICE



Inner barrel stave power consumption:

- Nine IB mode detectors: 1.4 W

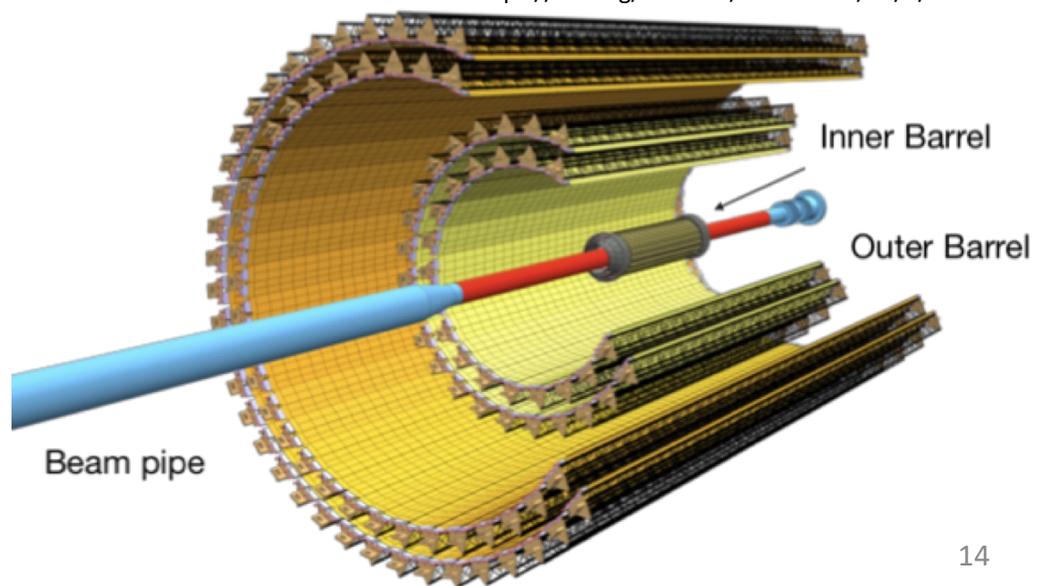
IB power density: 34 mW/cm²

OB stave power consumption:

- One Master chip mode: 157 mW
- Six Slave chip mode: 426 mW
- Full stave (two columns of seven detectors): 1.2 W

OB power density: 18.5 mW/cm²

<https://doi.org/10.1088/0954-3899/41/8/087002>



<https://indico.cern.ch/event/666016/contributions/2722251/attachments/1523408/2380925/20170914-ALPIDE-FoCal-Study-Aglieri.pdf>

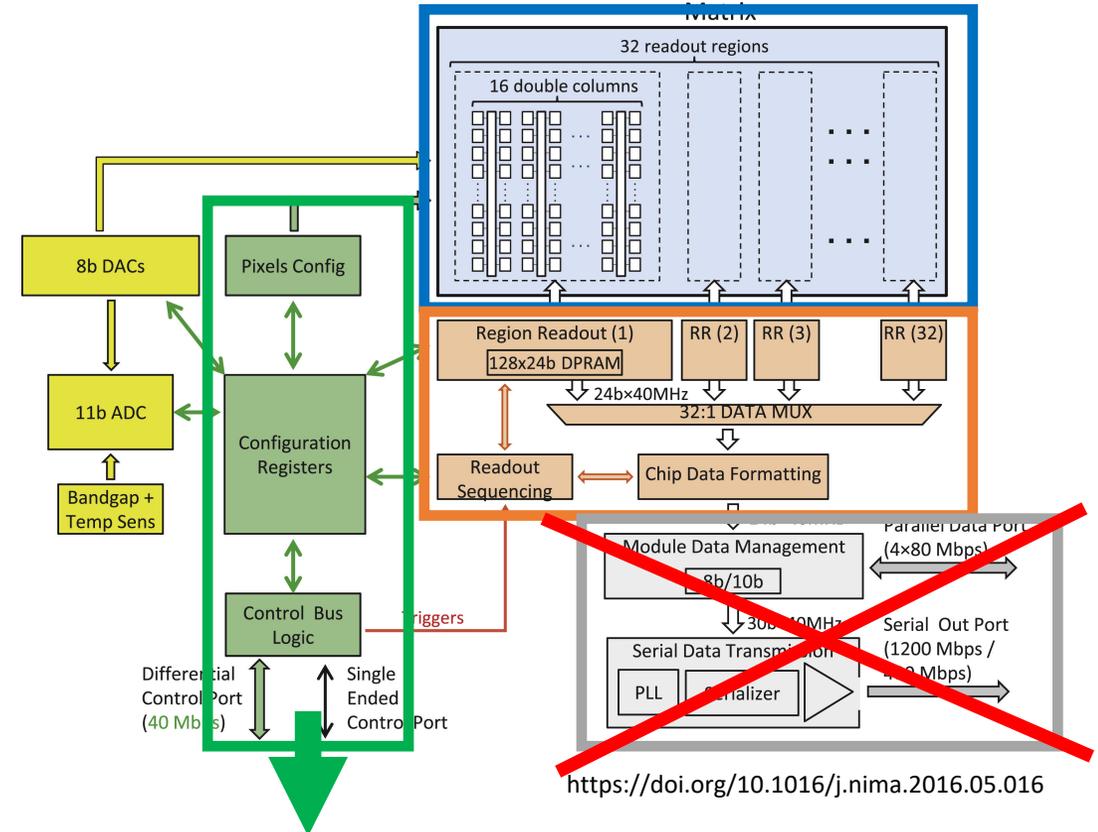
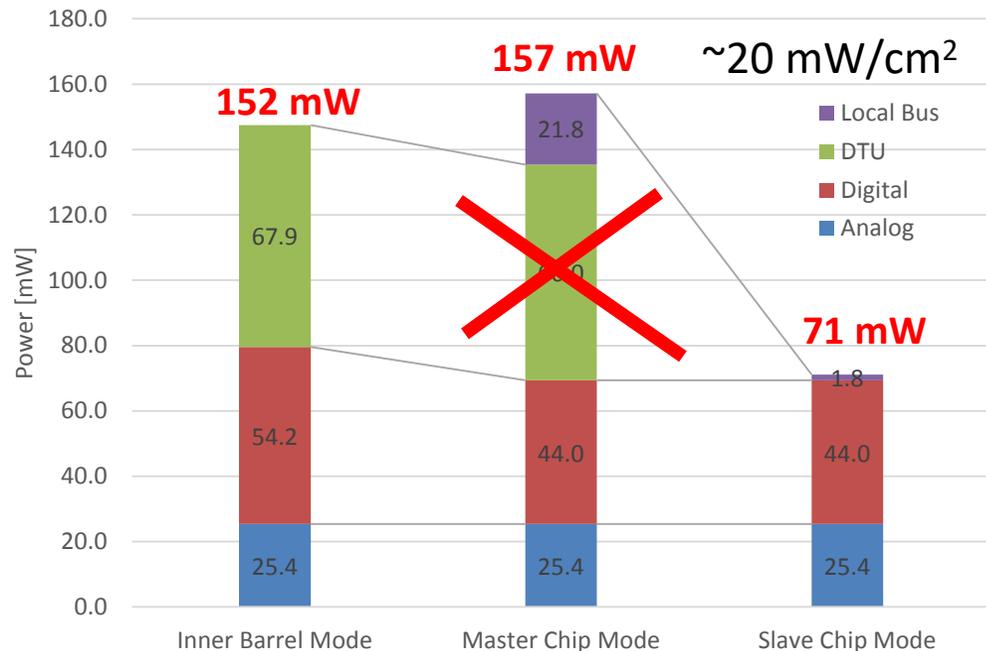
Fermi microstrip power density: 0.2 mW/cm²
 HEPD-01 microstrip power density: 10 mW/cm²

Power consumption reduction strategies

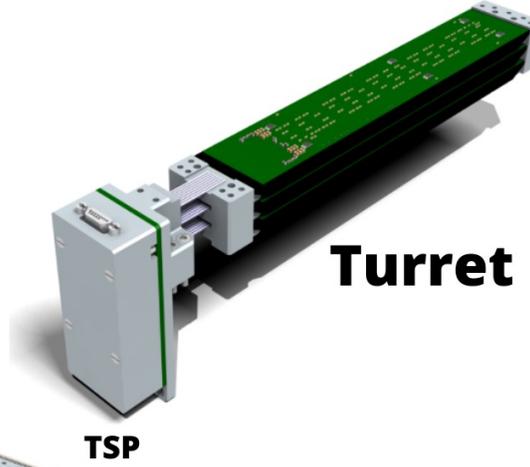
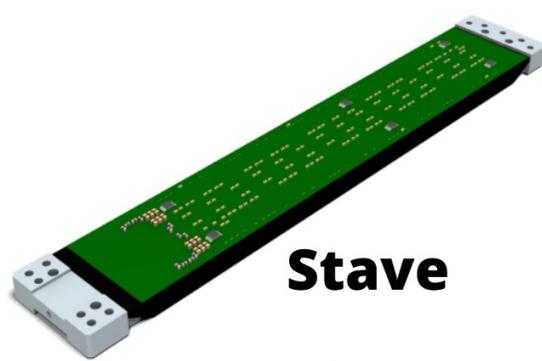
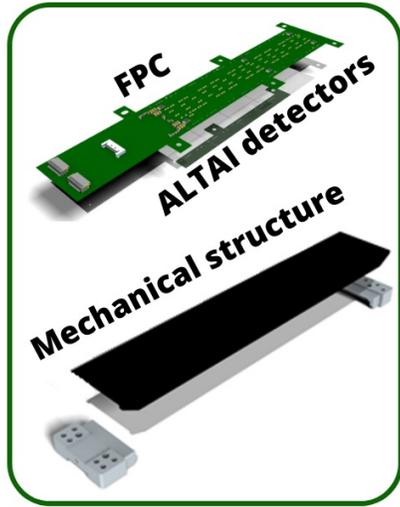
Power consumption have to be reduced to fit requirements of the HEPD-02 payload.

From power consumption characterisation, the high speed line is the most consuming element of the detector.

The first solution is to move the readout to the CTRL line. It avoids to activate the PLL.

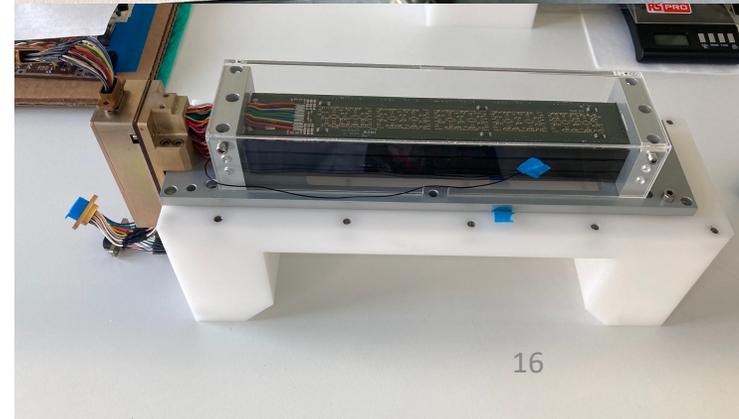
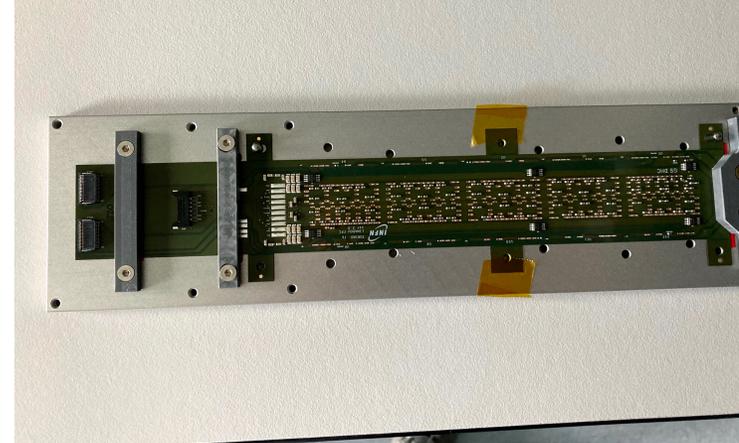


HEPD-02 tracker design



Design requirements:

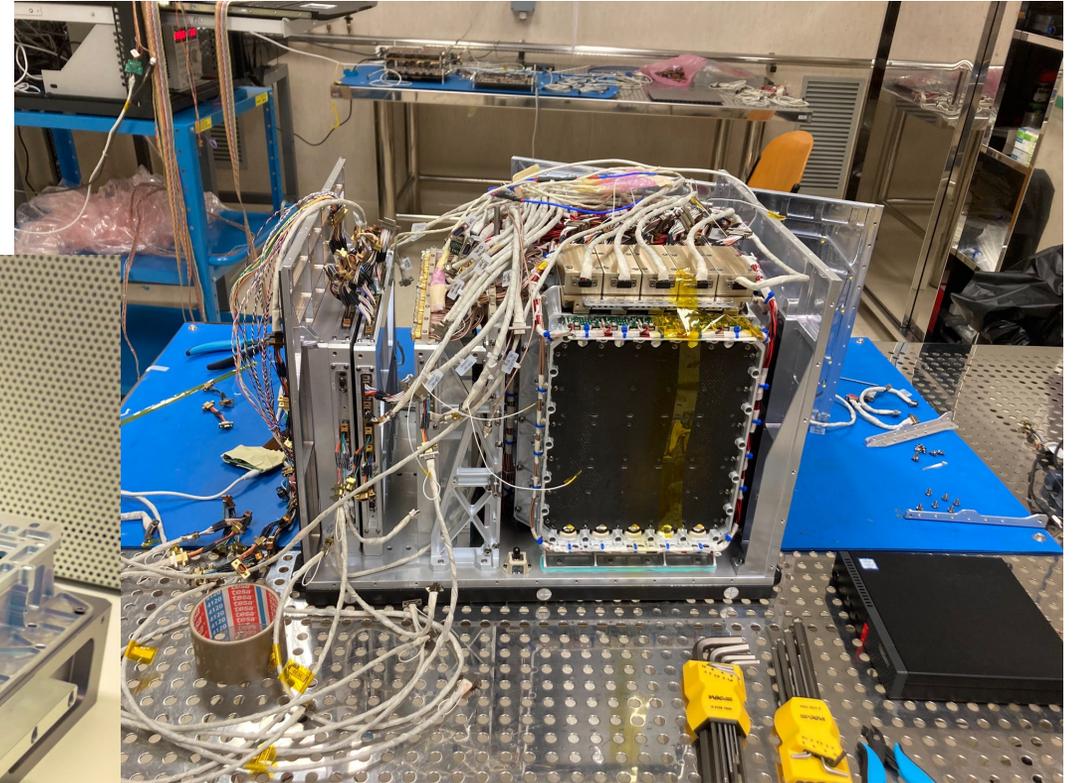
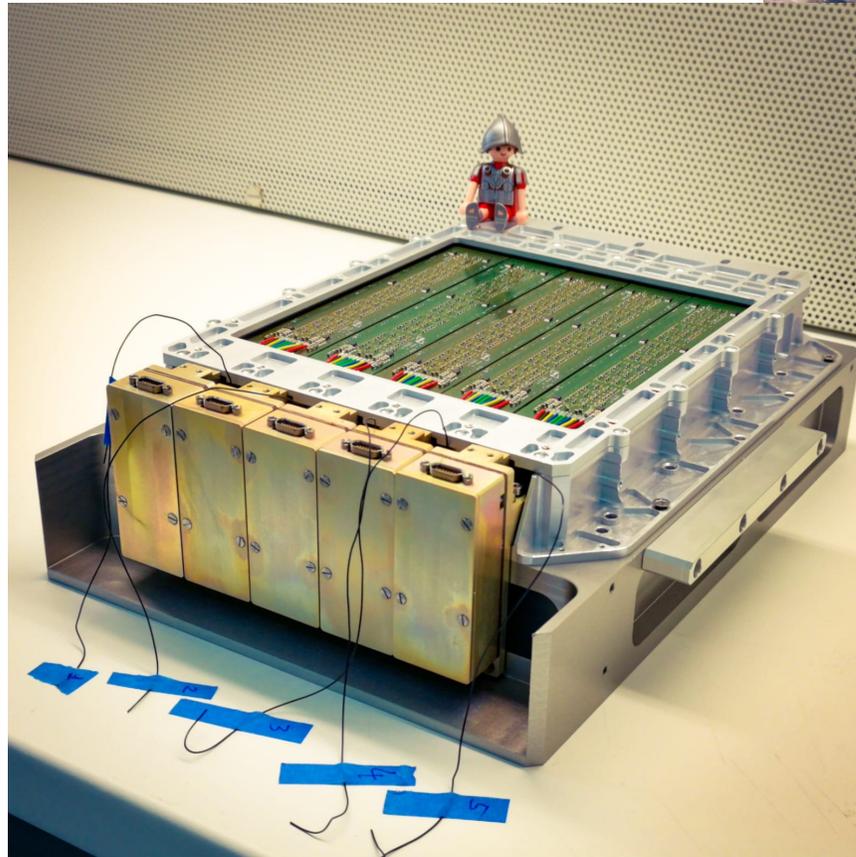
- Power consumption reduction
- Temperature control
- Mechanical stability
- Material budget minimisation



Tracker construction and integration

A team effort:

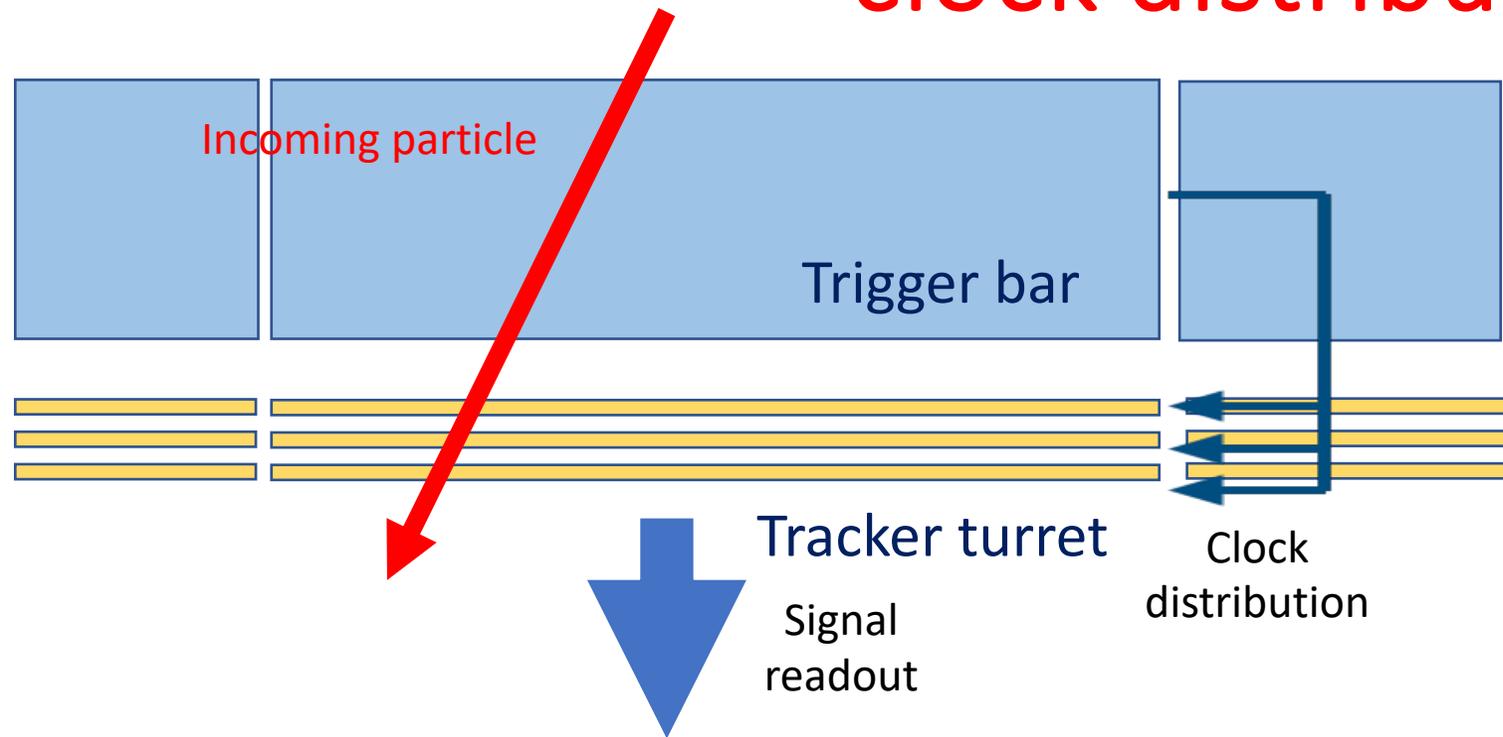
- HIC assembly in **Torino**
- Wire bonding in **Bari**
- Stave assembly in **Torino**
- Turret assembly in **Trento**
- Turret characterisation in **Trento**
- Tracker assembly in **Roma Tor Vergata**
- Integration on HEPD-02 in **Roma Tor Vergata**



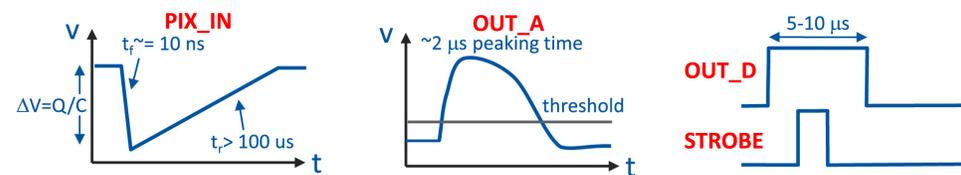
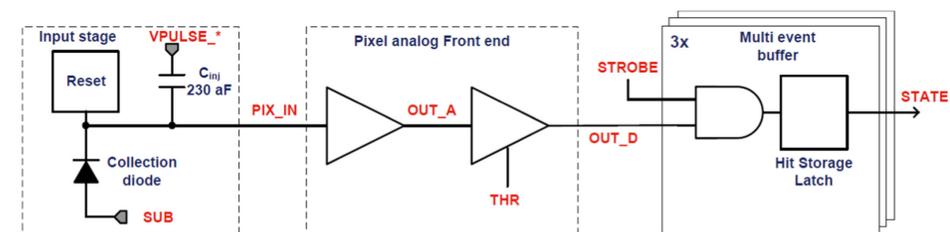
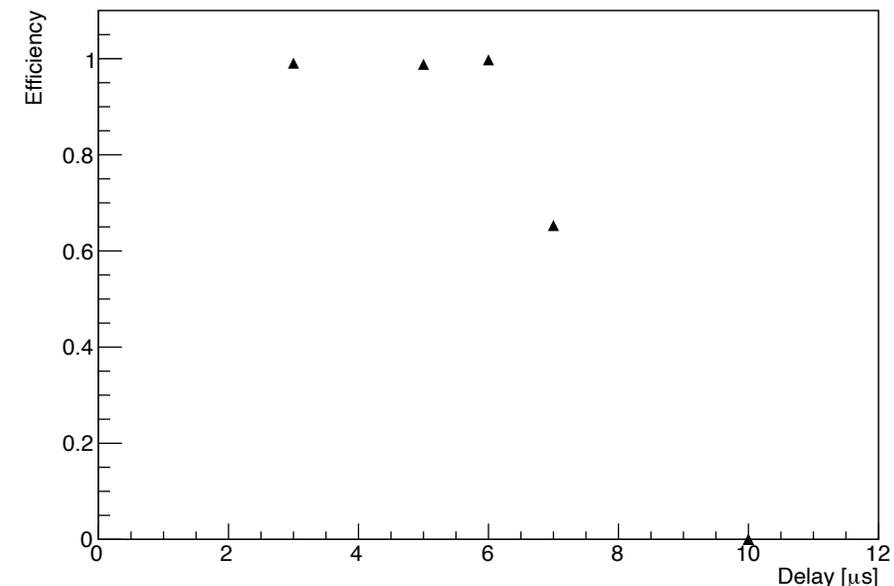
Production summary:

- 84 HIC assembled
- 48 STAVE assembled
- 11 turrets assembled (1 EM level, 10 QM/FM level)
- 2 trackers

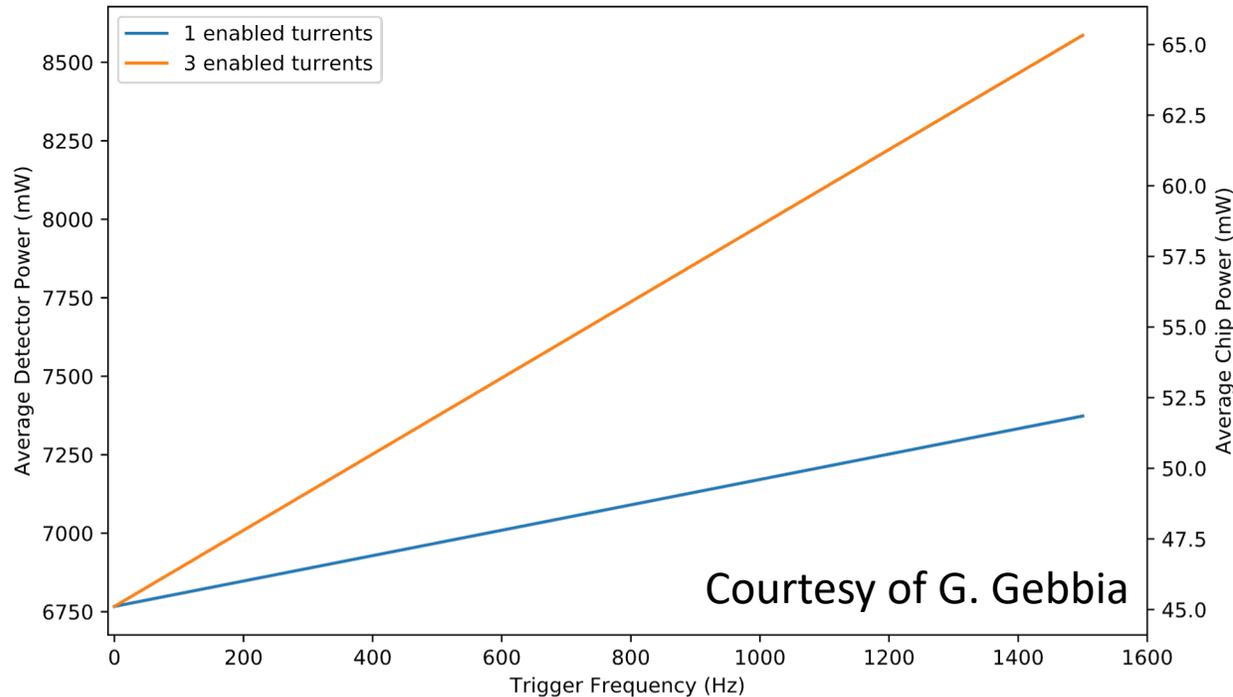
Power consumption reduction: clock distribution



- Analog front-end is kept constantly powered on
- The digital part is needed only for the readout of the data
- The clock is distributed only after the trigger signal is produced
- The smart segmentation of trigger allows to distribute the clock only to the section of tracker involved on the event



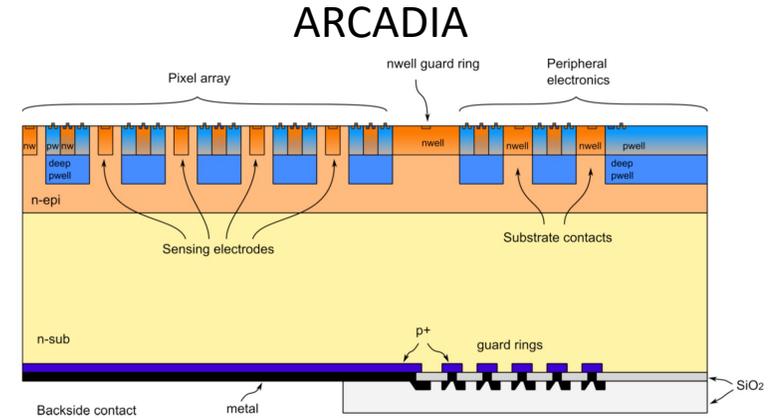
Full tracker power consumption



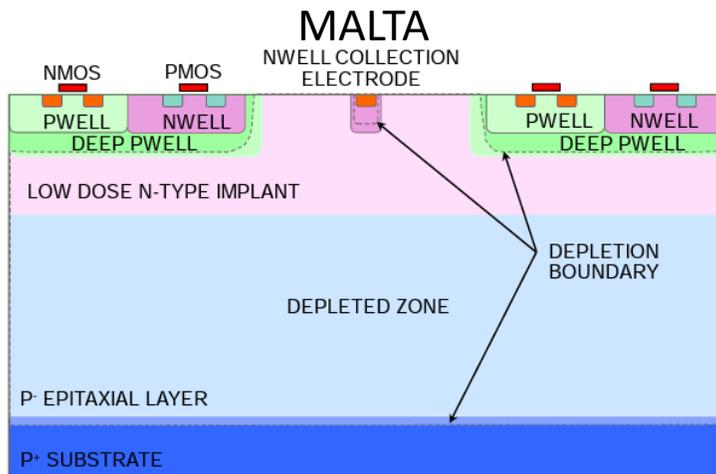
- Power consumption is plot as a function of trigger rate
- To increase the probability to intercept the section of the tracker hit by the particle, three turrets are read out
- Power consumption of the full tracker in this configuration is well below the 10 W of HEPD-01 tracker
- The maximum trigger rate will be defined by the dead time required for the readout.

MAPS evolution: DMAPS

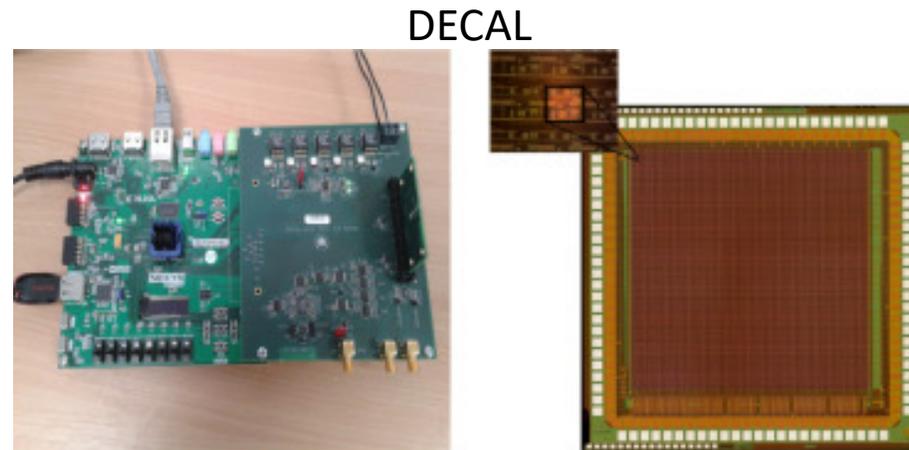
- One of the most impacting limits of MAPS is the low radiation hardness
- The design of detectors that can be operated in a fully depleted state
- The use of a detector in a full depleted state also increase the timing performance of the detector



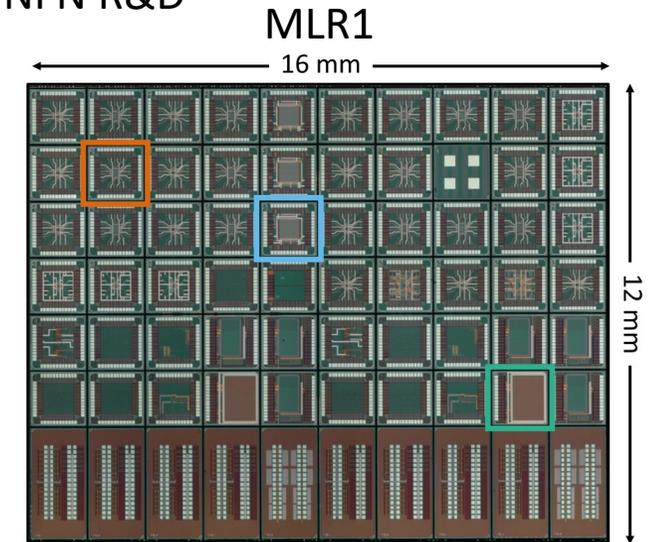
L-Foundry, 110 nm
Multi-purpose INFN R&D



Towers Semiconductors, 180 nm
R&D for ATLAS experiment

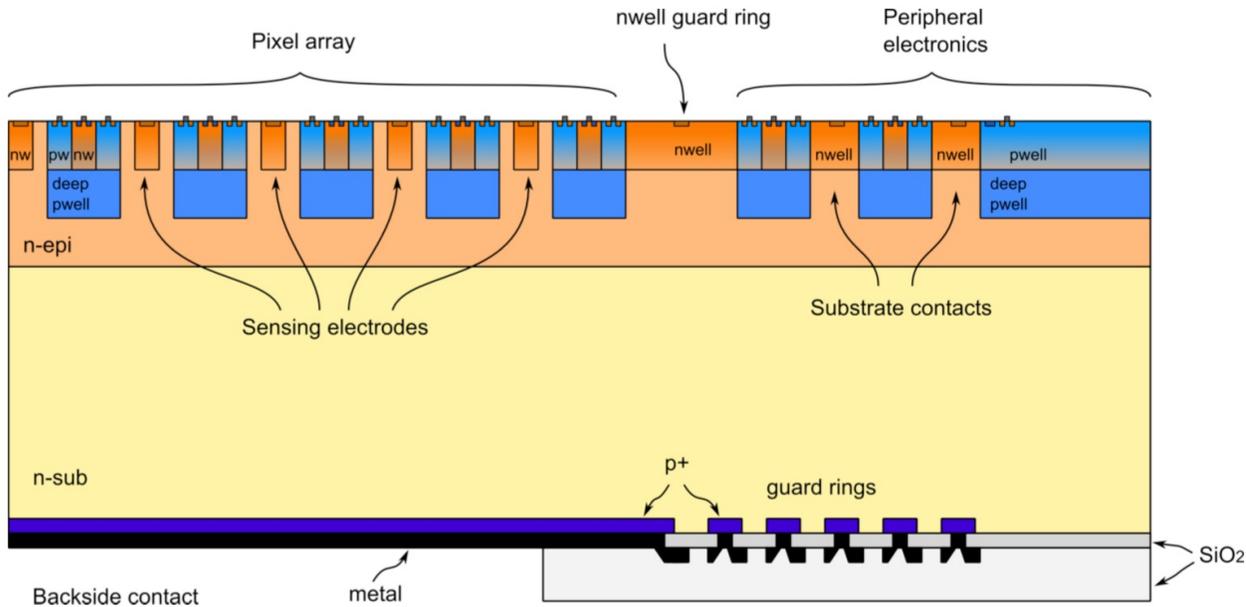


(a) (b)
Towers Semiconductors, 180 nm
Larger pixels for calorimetry applications



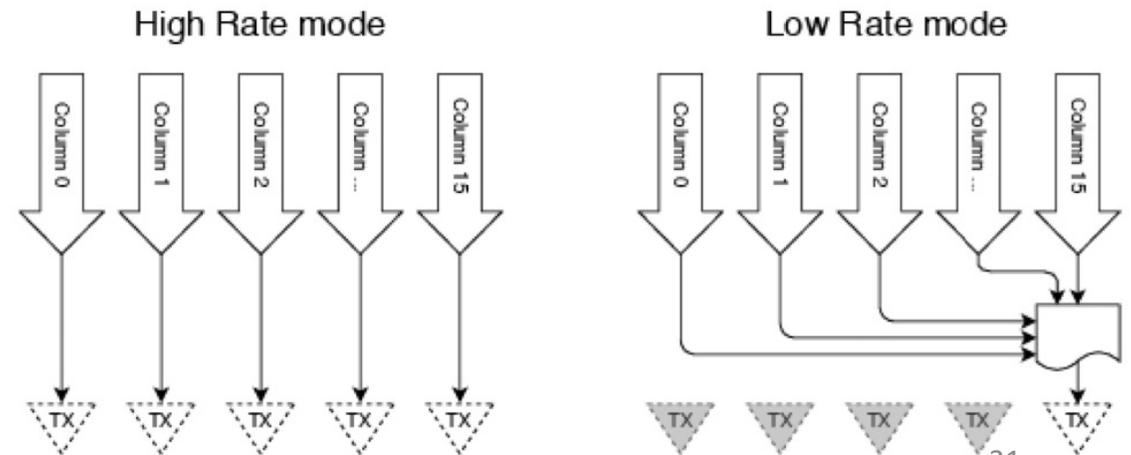
Towers Semiconductors, 65 nm
R&D for ALICE experiment

Designed (also) for space: ARCADIA



Requirements	
Pixel pitch [μm]	20 - 25
Thickness [μm]	50 - 500
Scalability [cm]	Up to $\sim 4 \times 4$
Hit rate	10 - 100
Timing resolution [ns]	10
Power consumption [mW/cm^2]	<20
Radiation hardness [Mrad]	1

- Developed on the framework of a INFN group V call as multi-purpose platform
- The production of the last version, MD3 was completed at the beginning of 2023
- Tests are ongoing
- The target of 10 mW/cm^2 has been achieved in a dedicated Low Rate mode



ARCADIA ongoing activities @TN

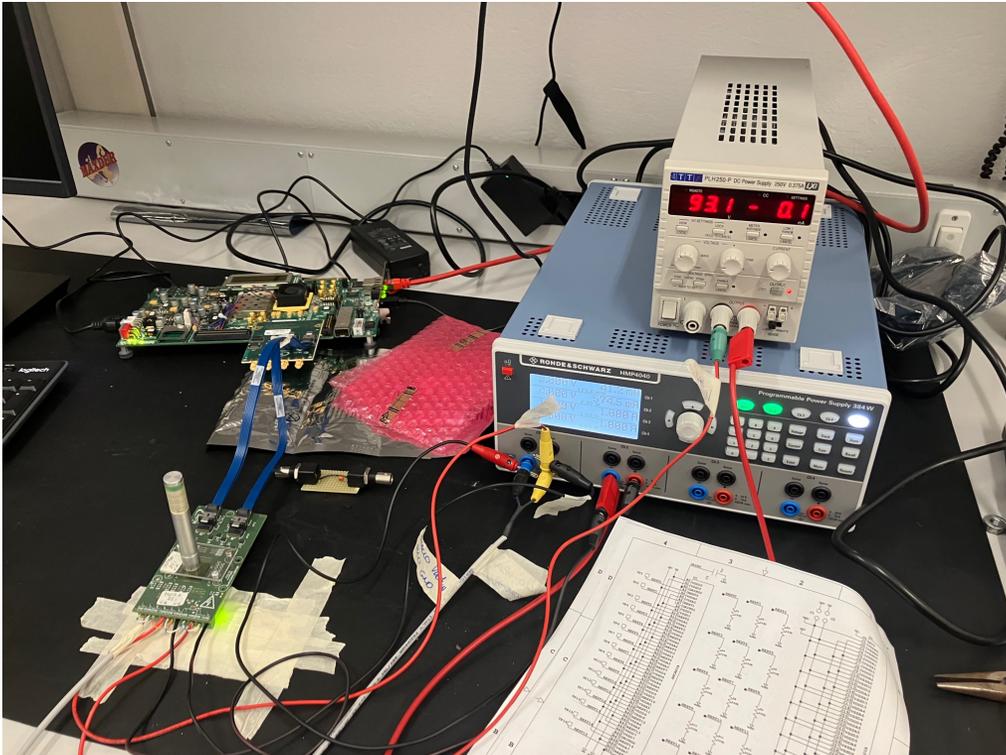
- Noise and threshold characterisation
- Software development
 - External trigger
 - Characterisation tool developing

Space mode tests:

- Power consumption characterisation:
 - Static measurements
 - Dynamic measurement
- Response as a function of the temperature
- Test of data acquisition limits

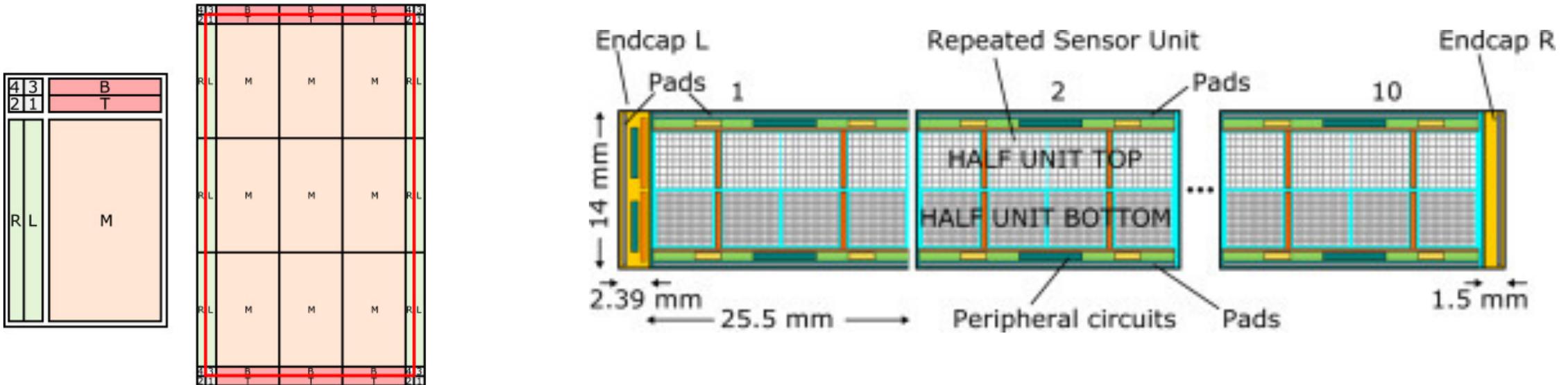
Test at high rate @Protontherapy centre:

- Procurement of fast scintillators and SiPMs
- Procurement of a fast electronic readout chain
- Test of the trigger chain
- Protontherapy test plan
- Beam test
- Data analysis



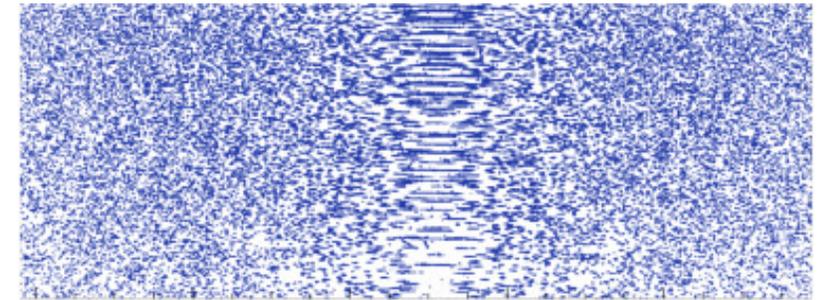
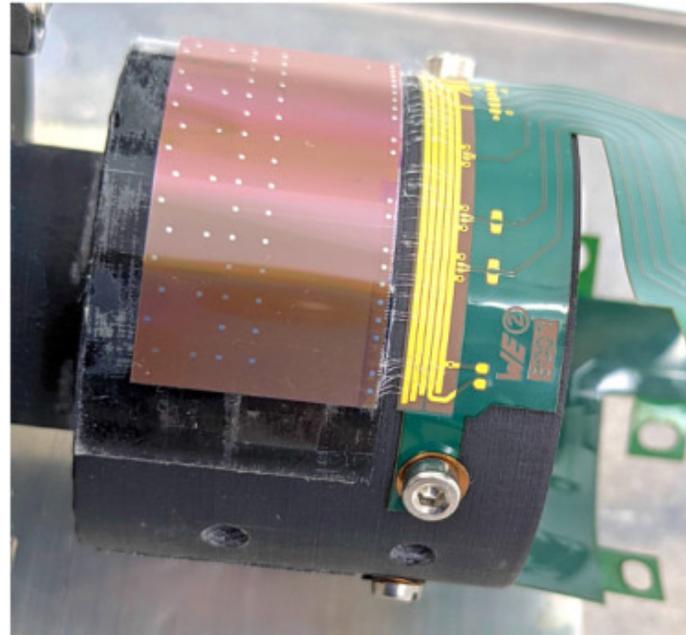
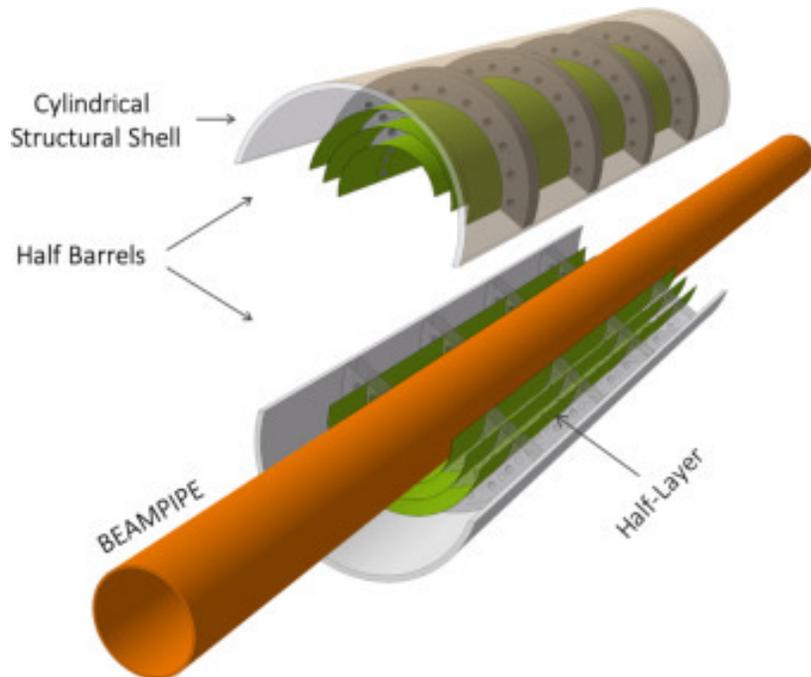
MAPS evolution: Stitching

- The small dimension of the currently available MAPS requires complex assembly procedures, power distribution and mechanical support
- The realisation of wafer-scale detector would widely increase the design possibilities
- The solution pursued by most R&D projects is [stitching](#)
- Stitching technique allows to connect single reticles to obtain a larger structures (usual reticles are limited to $\sim 2 \times 3 \text{ cm}^2$)
- ALICE collaboration R&D team has recently got the first batch of stitched detectors and the first tests are ongoing



MAPS evolution: curvature

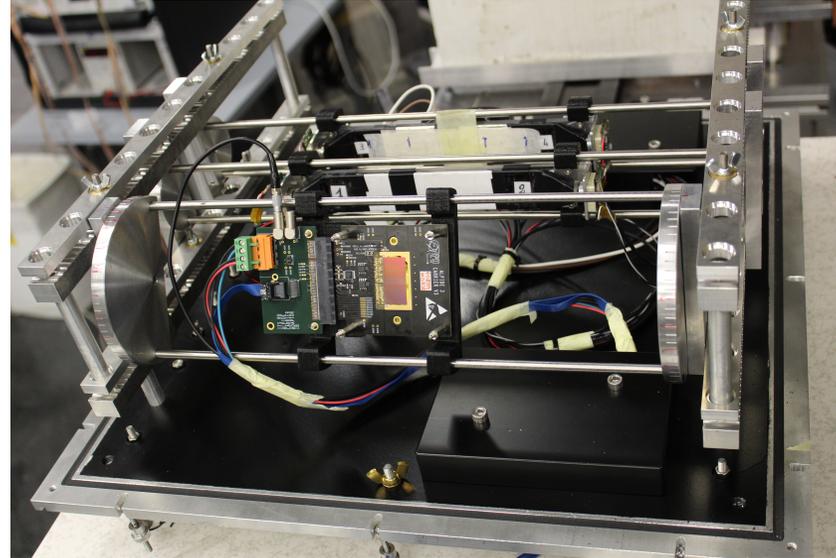
- Thinning procedures are well established in MAPS production
- With a further reduction from the 50 μm of ALPIDE produced for ALICE Inner Barrel, it is possible to bend the detector
- ALICE ITS3 design will require a full cylindrical shape, with the innermost layer designed with a 18 mm curvature radius.
- Tests have been carried out with ALPIDE, with good results



Beam trough a bent ALPIDE

Development activities: lab characterisation

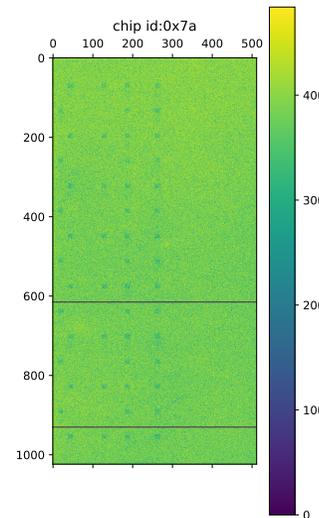
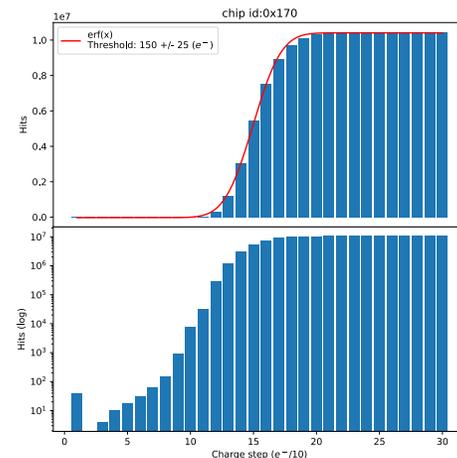
Setup design and realisation



Acquisitions with cosmic rays

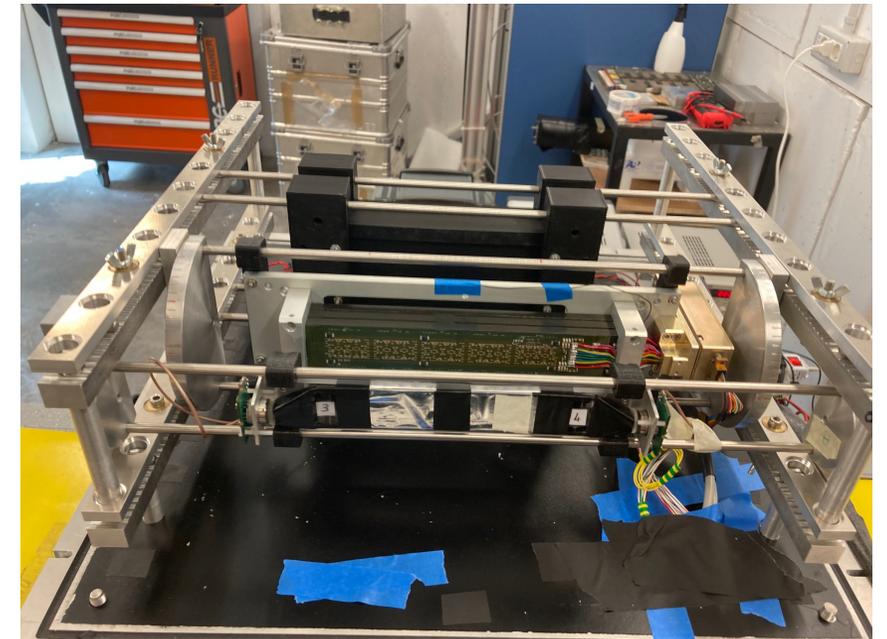
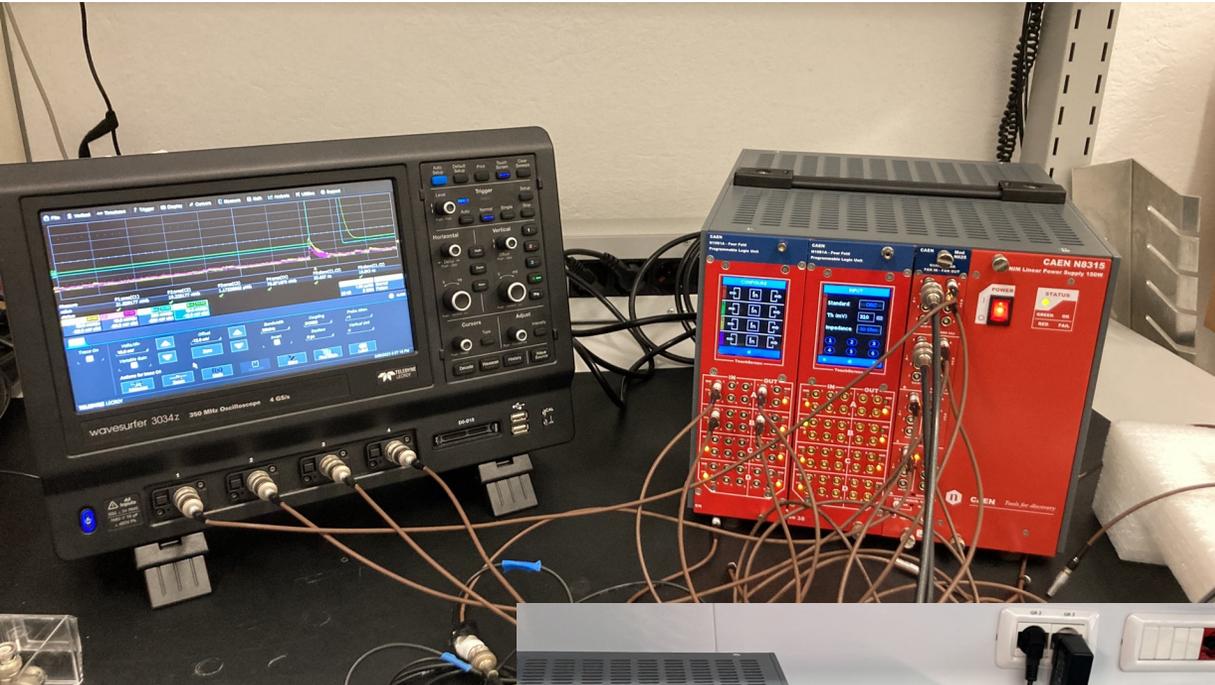


Power consumption charcaterisation



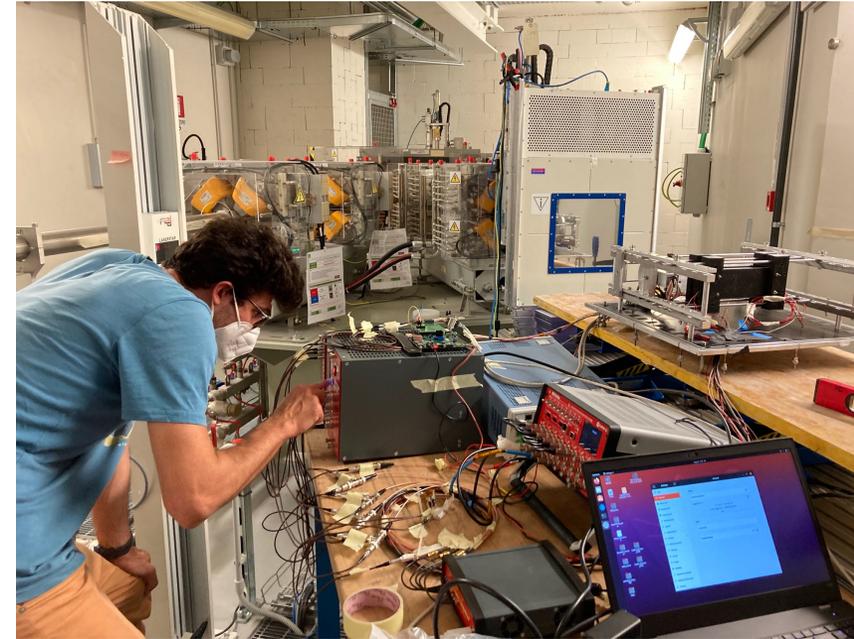
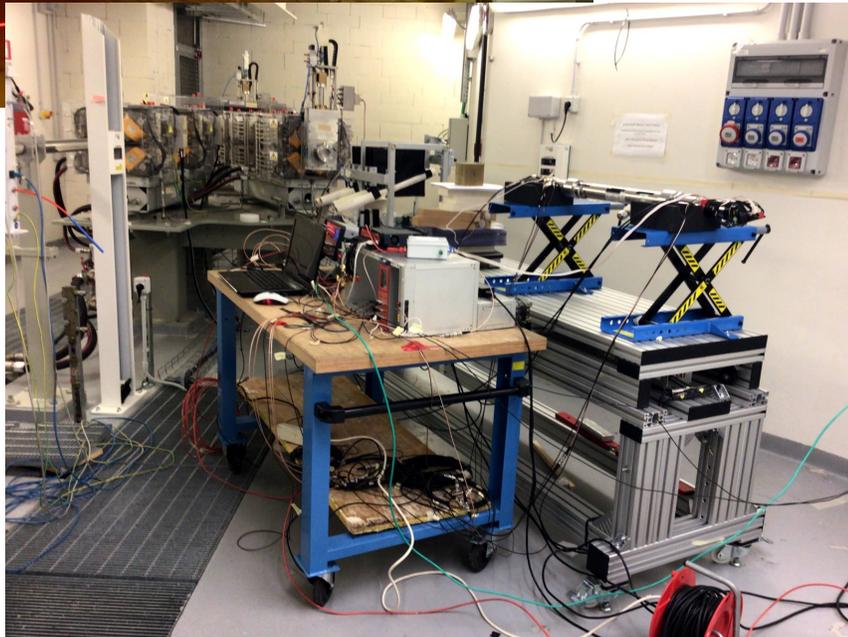
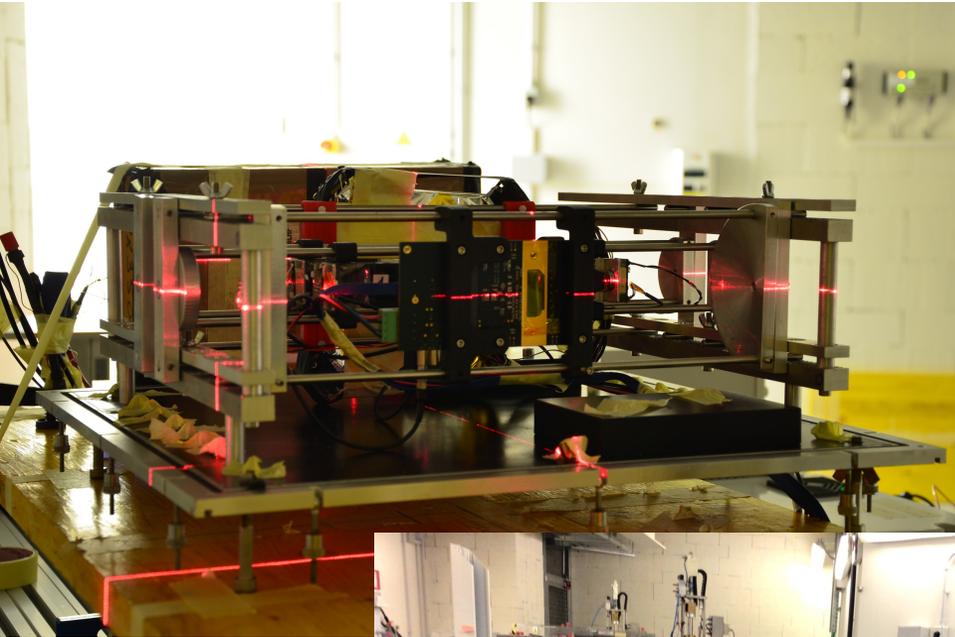
Parameter scans

Development activities: trigger systems



Fast scintillators
Thin slabs
Dense crystals for calorimetry

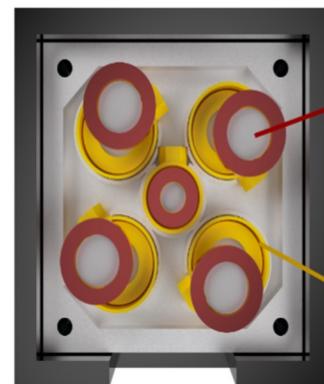
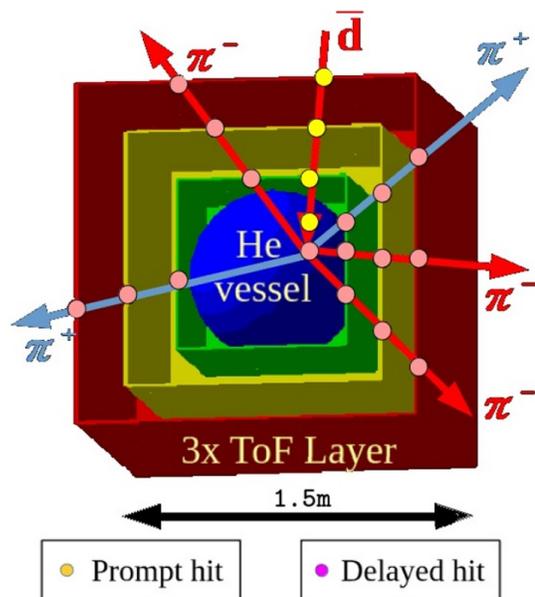
Development activities: beam tests



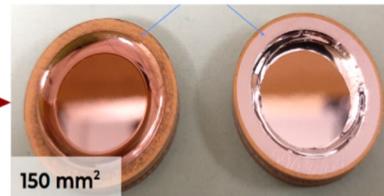
- Two beam lines
- Energies between 70 and 228 MeV (lower energies reachable with degrader)
- Available on week days from 7pm to 10 or 10:30pm and on Saturday mornings
- 1 “preposto” is from the group, available for groups with similar beam requirements (physics line, low rates)

Conclusions

- The APP group in Trento was constituted in 2017
- In 6 years we were able to design, realise, qualify and characterise a tracker for space applications realised with an innovative technology
- MAPS technology was promoted from TRL 4 to TRL 8
- In the process, we gained experience in all the process, we equipped our labs and we built our network of facilities and labs that can supply us the infrastructures we lack
- Other new space-based initiatives (LEM and ADHD) are under development
- With the HEPD-02 ready for shipment to China, we are ready for a new adventure

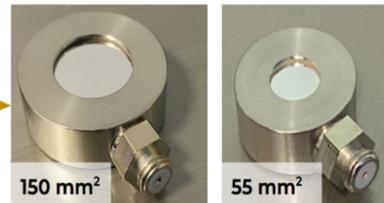


ΔE detector:
Silicon PIPS
100 μm
AMETEK



150 mm²

E detector:
Silicon PIPS
300 μm
MIRION



150 mm²

55 mm²

